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REVISION HISTORY

10/08—Rev. D to Rev. E

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1/08—Rev. C to Rev. D

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3/07—Rev. B to Rev. C

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12/06—Rev. A to Rev. B

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1/04—Rev. 0 to Rev. A

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Updated Outline Dimensions	18

10/96—Revision 0: Initial Version

SPECIFICATIONS

Each amplifier channel at $T_A = 25^\circ\text{C}$, $V_S = \pm 5\text{ V}$, $R_S = 50\ \Omega$, $R_L = 500\ \Omega$, $C_L = 5\text{ pF}$, $V_{\text{REF}} = 2.50\text{ V}$ (scaling = 20 dB/V), 0 dB to 48 dB gain range (preamplifier gain = 14 dB), $\text{VOCM} = 2.5\text{ V}$, C_1 and $C_2 = 0.1\ \mu\text{F}$ (see Figure 37), unless otherwise noted.

Table 1.

Parameter	Conditions	Min	Typ	Max	Unit
INPUT CHARACTERISTICS					
Preamplifier					
Input Resistance			300		k Ω
Input Capacitance			8.5		pF
Input Bias Current			–27		mA
Peak Input Voltage	Preamplifier gain = 14 dB		±400		mV
	Preamplifier gain = 20 dB		±200		mV
Input Voltage Noise	VGN = 2.9 V, $R_S = 0\ \Omega$				
	Preamplifier gain = 14 dB		0.8		nV/ $\sqrt{\text{Hz}}$
	Preamplifier gain = 20 dB		0.73		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	Independent of gain		3.0		pA/ $\sqrt{\text{Hz}}$
Noise Figure	$R_S = 50\ \Omega$, $f = 10\text{ MHz}$, VGN = 2.9 V		2.3		dB
	$R_S = 200\ \Omega$, $f = 10\text{ MHz}$, VGN = 2.9 V		1.1		dB
DSX					
Input Resistance			175		Ω
Input Capacitance			3.0		pF
Peak Input Voltage			2.5 ± 2		V
Input Voltage Noise	VGN = 2.9 V		1.8		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	VGN = 2.9 V		2.7		pA/ $\sqrt{\text{Hz}}$
Noise Figure	$R_S = 50\ \Omega$, $f = 10\text{ MHz}$, VGN = 2.9 V		8.4		dB
	$R_S = 200\ \Omega$, $f = 10\text{ MHz}$, VGN = 2.9 V		12		dB
Common-Mode Rejection Ratio	$f = 1\text{ MHz}$, VGN = 2.65 V		–20		dB
OUTPUT CHARACTERISTICS					
–3 dB Bandwidth	Constant with gain		40		MHz
Slew Rate	VGN = 1.5 V, output = 1 V step		170		V/ μs
Output Signal Range	$R_L \geq 500\ \Omega$		2.5 ± 1.5		V
Output Impedance	$f = 10\text{ MHz}$		2		Ω
Output Short-Circuit Current			±40		mA
Harmonic Distortion	VGN = 1 V, $V_{\text{OUT}} = 1\text{ V p-p}$				
HD2	$f = 1\text{ MHz}$		–54		dBc
HD3	$f = 1\text{ MHz}$		–67		dBc
HD2	$f = 10\text{ MHz}$		–43		dBc
HD3	$f = 10\text{ MHz}$		–48		dBc
Two-Tone Intermodulation Distortion (IMD)	VGN = 2.9 V, $V_{\text{OUT}} = 1\text{ V p-p}$				
	$f = 1\text{ MHz}$		–74		dBc
	$f = 10\text{ MHz}$		–71		dBc
Third-Order Intercept	$f = 10\text{ MHz}$, VGN = 2.65 V, $V_{\text{OUT}} = 1\text{ V p-p}$, input referred		–12.5		dBm
1 dB Compression Point	$f = 1\text{ MHz}$, VGN = 2.9 V, output referred		15		dBm
Channel-to-Channel Crosstalk	$V_{\text{OUT}} = 1\text{ V p-p}$, $f = 1\text{ MHz}$, Channel 1: VGN = 2.65 V, inputs shorted, Channel 2: VGN = 1.5 V (mid gain)		–30		dB
Group Delay Variation	1 MHz < f < 10 MHz, full gain range		±2		ns
VOCM Input Resistance			45		k Ω

AD604

Parameter	Conditions	Min	Typ	Max	Unit
ACCURACY					
Absolute Gain Error					
0 dB to 3 dB	$0.25\text{ V} < \text{VGN} < 0.400\text{ V}$	-1.2	+0.75	+3	dB
3 dB to 43 dB	$0.400\text{ V} < \text{VGN} < 2.400\text{ V}$	-1.0	± 0.3	+1.0	dB
43 dB to 48 dB	$2.400\text{ V} < \text{VGN} < 2.65\text{ V}$	-3.5	-1.25	+1.2	dB
Gain Scaling Error	$0.400\text{ V} < \text{VGN} < 2.400\text{ V}$		± 0.25		dB/V
Output Offset Voltage	$\text{VREF} = 2.500\text{ V}, \text{VOCM} = 2.500\text{ V}$	-50	± 30	+50	mV
Output Offset Variation	$\text{VREF} = 2.500\text{ V}, \text{VOCM} = 2.500\text{ V}$		30	50	mV
GAIN CONTROL INTERFACE					
Gain Scaling Factor	$\text{VREF} = 2.5\text{ V}, 0.4\text{ V} < \text{VGN} < 2.4\text{ V}$	19	20	21	dB/V
	$\text{VREF} = 1.67\text{ V}$		30		dB/V
Gain Range	Preamplifier gain = 14 dB		0 to 48		dB
	Preamplifier gain = 20 dB		6 to 54		dB
Input Voltage (VGN) Range	20 dB/V, $\text{VREF} = 2.5\text{ V}$		0.1 to 2.9		V
Input Bias Current			-0.4		μA
Input Resistance			2		M Ω
Response Time	48 dB gain change		0.2		μs
VREF Input Resistance			10		k Ω
POWER SUPPLY					
Specified Operating Range	One complete channel		± 5		V
	One DSX only		5		V
Power Dissipation	One complete channel		220		mW
	One DSX only		95		mW
Quiescent Supply Current	VPOS, one complete channel		32	36	mA
	VPOS, one DSX only		19	23	mA
	VNEG, one preamplifier only	-15	-12		mA
Powered Down	VPOS, $\text{VGN} < 50\text{ mV}$, one channel		1.9	3.0	mA
	VNEG, $\text{VGN} < 50\text{ mV}$, one channel		-150		μA
Power-Up Response Time	48 dB gain change, $\text{V}_{\text{OUT}} = 2\text{ V p-p}$		0.6		μs
Power-Down Response Time			0.4		μs

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter ^{1, 2}	Rating
Supply Voltage $\pm V_S$	
Pin 17 to Pin 20 (with Pin 16, Pin 22 = 0 V)	± 6.5 V
Input Voltages	
Pin 1, Pin 2, Pin 11, Pin 12	$V_{POS}/2 \pm 2$ V continuous
Pin 4, Pin 9	± 2 V
Pin 5, Pin 8	V_{POS} , V_{NEG}
Pin 6, Pin 7, Pin 13, Pin 14, Pin 23, Pin 24	V_{POS} , 0 V
Internal Power Dissipation	
PDIP (N)	2.2 W
SOIC (RW)	1.7 W
SSOP (RS)	1.1 W
Operating Temperature Range	-40°C to $+85^{\circ}\text{C}$
Storage Temperature Range	-65°C to $+150^{\circ}\text{C}$
Lead Temperature, Soldering 60 sec	300°C
θ_{JA} ³	
AD604AN	105°C/W
AD604AR	73°C/W
AD604ARS	112°C/W
θ_{JC} ³	
AD604AN	35°C/W
AD604AR	38°C/W
AD604ARS	34°C/W

¹ Pin 1, Pin 2, Pin 11 to Pin 14, Pin 23, and Pin 24 are part of a single-supply circuit. The part is likely to suffer damage if any of these pins are accidentally connected to VN.

² When driven from an external low impedance source.

³ Using MIL-STD-883 test method G43-87 with a 1S (2-layer) test board.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

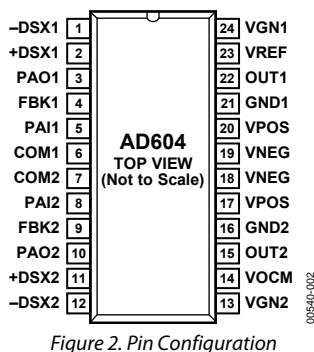


Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	-DSX1	Channel 1 Negative Signal Input to DSX1.
2	+DSX1	Channel 1 Positive Signal Input to DSX1.
3	PAO1	Channel 1 Preamplifier Output.
4	FBK1	Channel 1 Preamplifier Feedback Pin.
5	PAI1	Channel 1 Preamplifier Positive Input.
6	COM1	Channel 1 Signal Ground. When this pin is connected to positive supply, Preamplifier 1 shuts down.
7	COM2	Channel 2 Signal Ground. When this pin is connected to positive supply, Preamplifier 2 shuts down.
8	PAI2	Channel 2 Preamplifier Positive Input.
9	FBK2	Channel 2 Preamplifier Feedback Pin.
10	PAO2	Channel 2 Preamplifier Output.
11	+DSX2	Channel 2 Positive Signal Input to DSX2.
12	-DSX2	Channel 2 Negative Signal Input to DSX2.
13	VGN2	Channel 2 Gain Control Input and Power-Down Pin. If this pin is grounded, the device is off; otherwise, positive voltage increases gain.
14	VOCM	Input to this pin defines the common mode of the output at OUT1 and OUT2.
15	OUT2	Channel 2 Signal Output.
16	GND2	Ground.
17	VPOS	Positive Supply.
18	VNEG	Negative Supply.
19	VNEG	Negative Supply.
20	VPOS	Positive Supply.
21	GND1	Ground.
22	OUT1	Channel 1 Signal Output.
23	VREF	Input to this pin sets gain scaling for both channels to 2.5 V = 20 dB/V and 1.67 V = 30 dB/V.
24	VGN1	Channel 1 Gain Control Input and Power-Down Pin. If this pin is grounded, the device is off; otherwise, positive voltage increases gain.

TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise noted, G (preamplifier) = 14 dB, $V_{REF} = 2.5$ V (20 dB/V scaling), $f = 1$ MHz, $R_L = 500\ \Omega$, $C_L = 5$ pF, $T_A = 25^\circ\text{C}$, and $V_{SS} = \pm 5$ V.

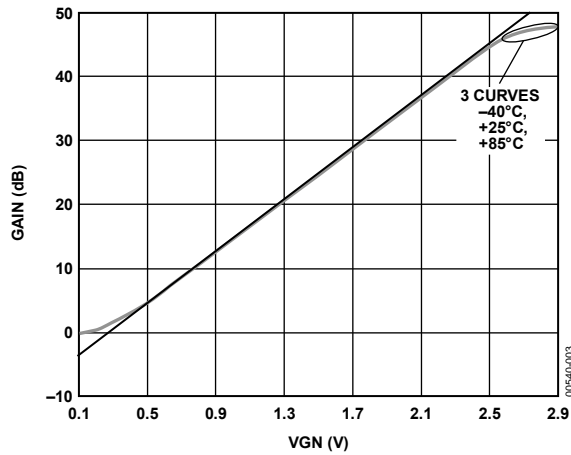


Figure 3. Gain vs. VGN for Three Temperatures

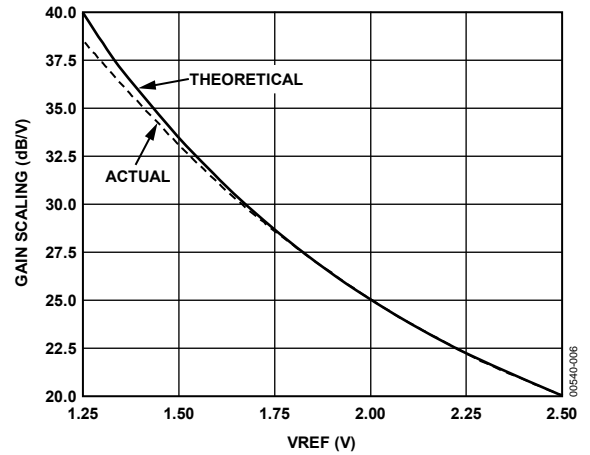


Figure 6. Gain Scaling vs. V_{REF}

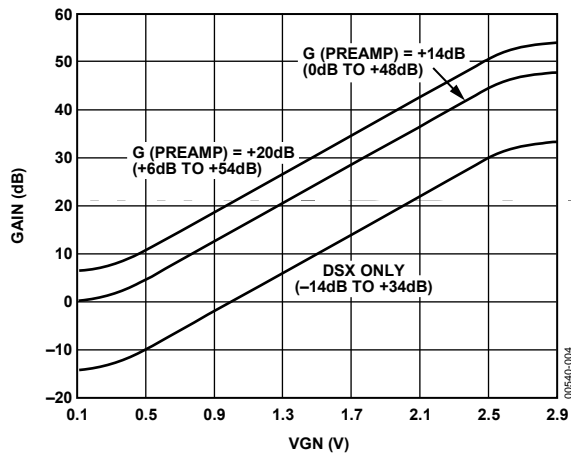


Figure 4. Gain vs. VGN for Different Preamplifier Gains

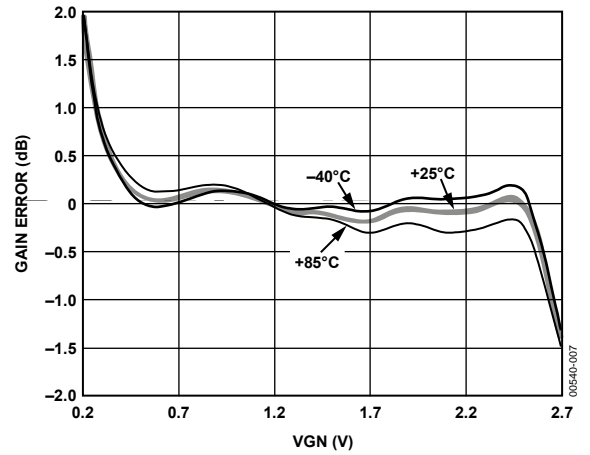


Figure 7. Gain Error vs. VGN

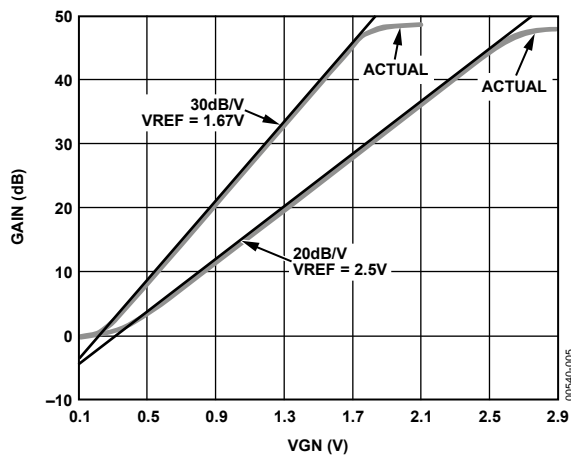


Figure 5. Gain vs. VGN for Different Gain Scalings

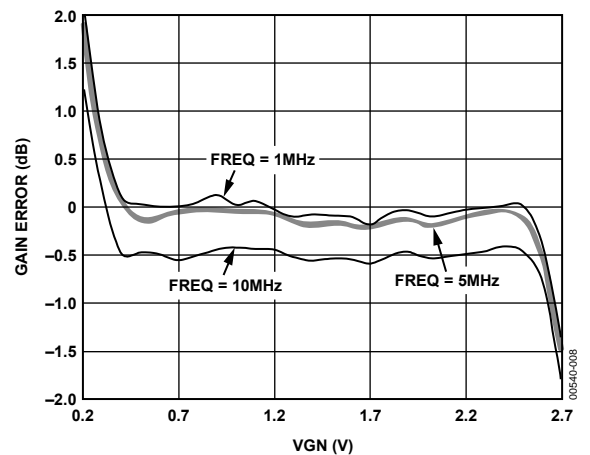


Figure 8. Gain Error vs. VGN at Different Frequencies

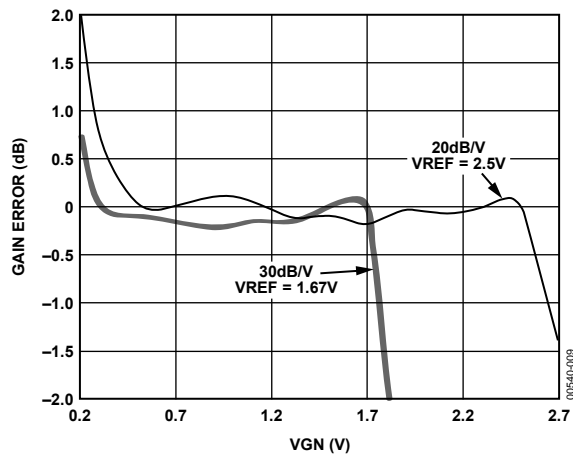


Figure 9. Gain Error vs. VGN for Two Gain Scaling Values

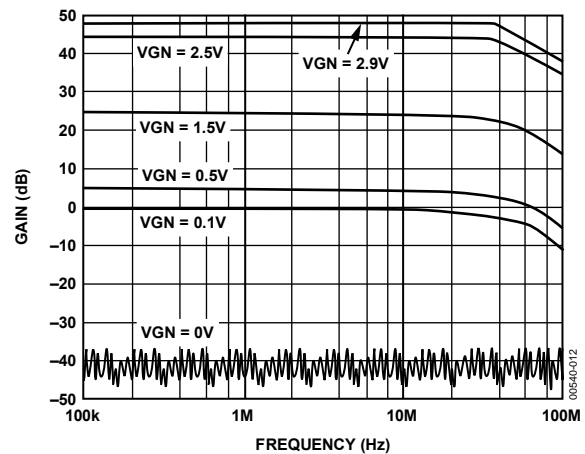


Figure 12. AC Response for Various Values of VGN

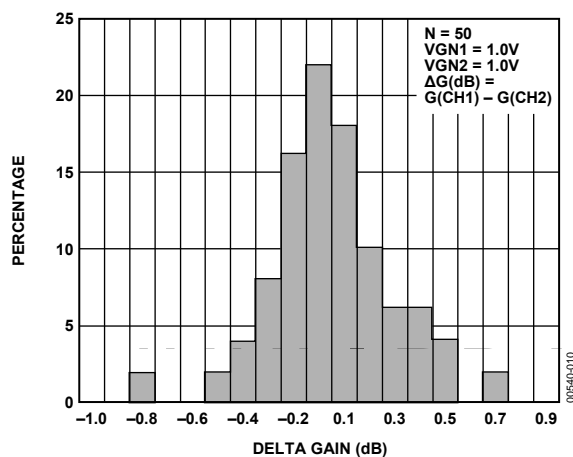


Figure 10. Gain Match; VGN1 = VGN2 = 1.0 V

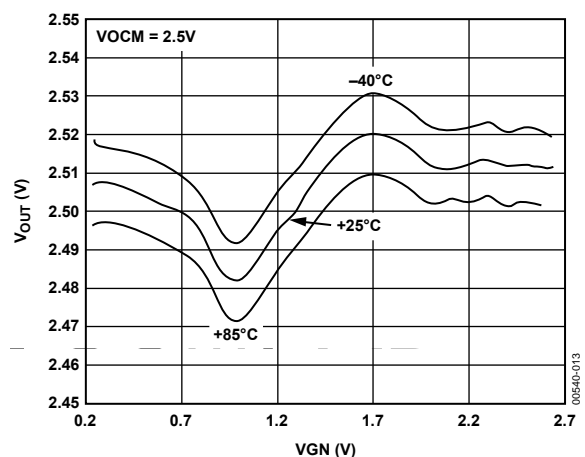


Figure 13. Output Offset vs. VGN for Three Temperatures

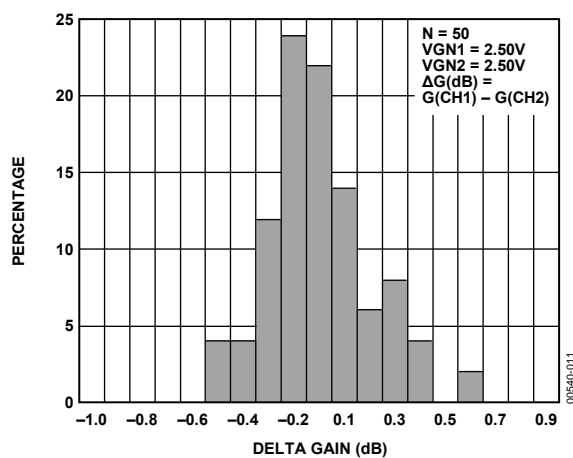


Figure 11. Gain Match; VGN1 = VGN2 = 2.50 V

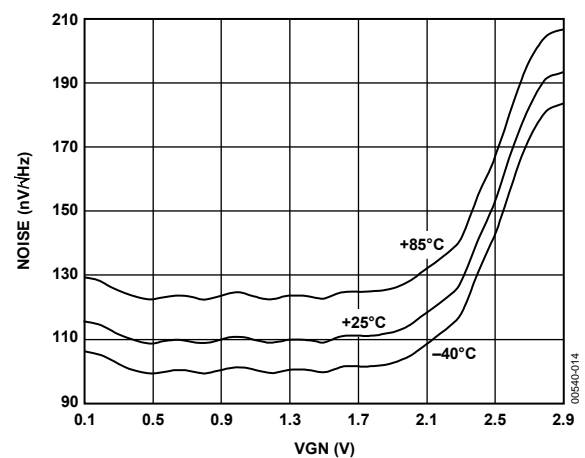


Figure 14. Output Referred Noise vs. VGN for Three Temperatures

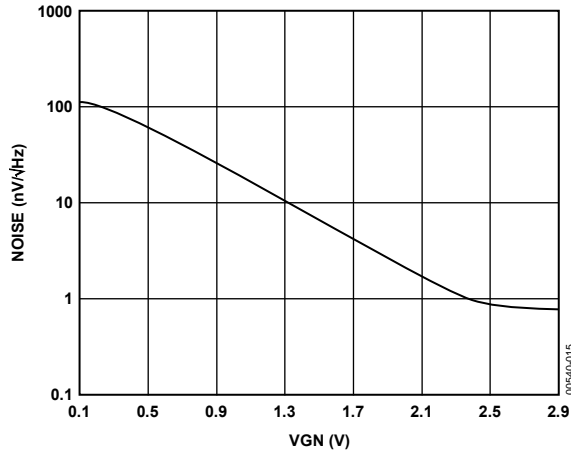


Figure 15. Input Referred Noise vs. VGN

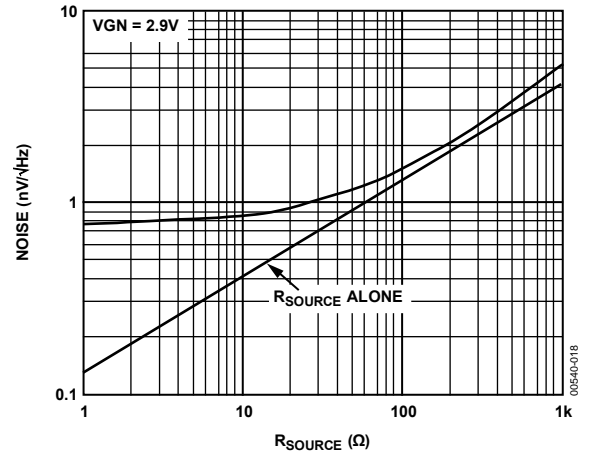


Figure 18. Input Referred Noise vs. R_{SOURCE}

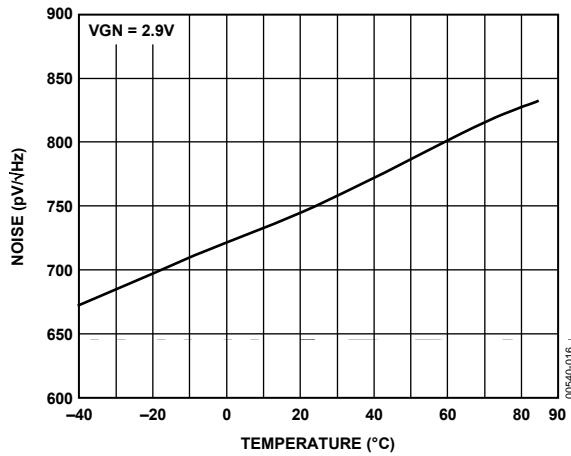


Figure 16. Input Referred Noise vs. Temperature

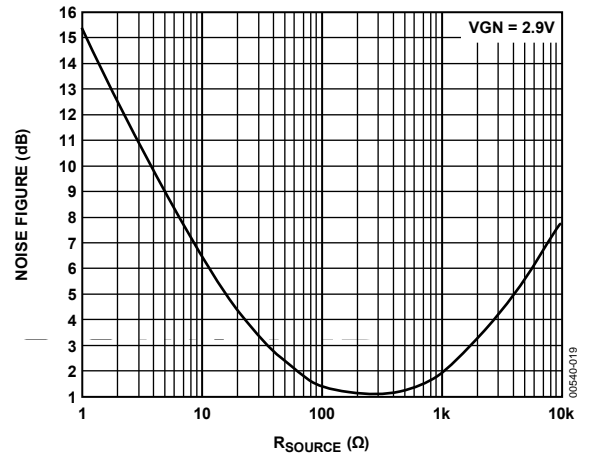


Figure 19. Noise Figure vs. R_{SOURCE}

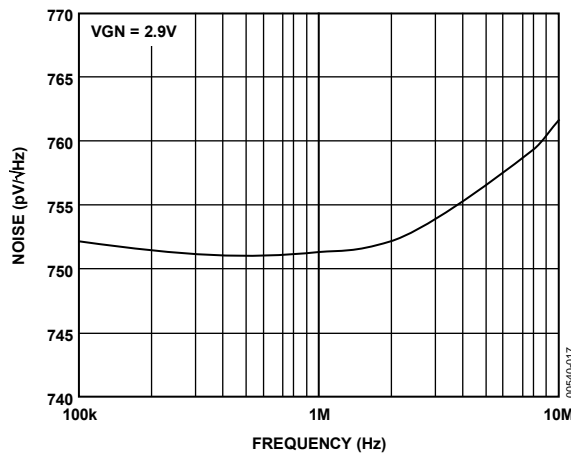


Figure 17. Input Referred Noise vs. Frequency

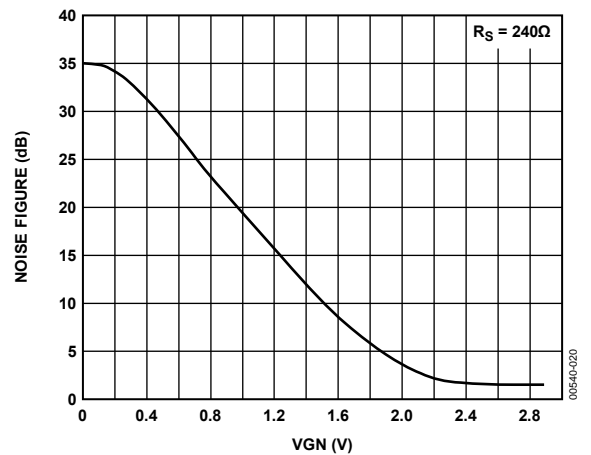


Figure 20. Noise Figure vs. VGN

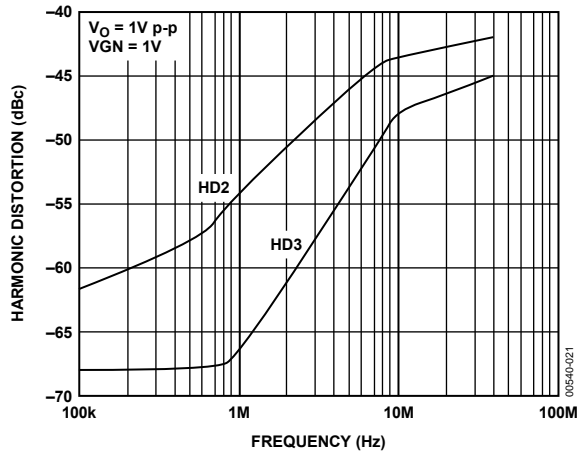


Figure 21. Harmonic Distortion vs. Frequency

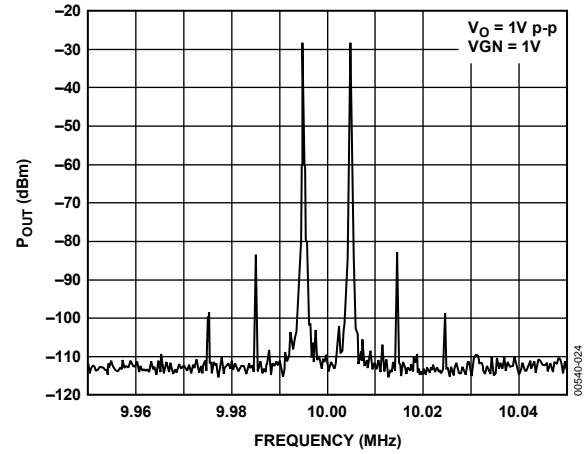


Figure 24. Intermodulation Distortion

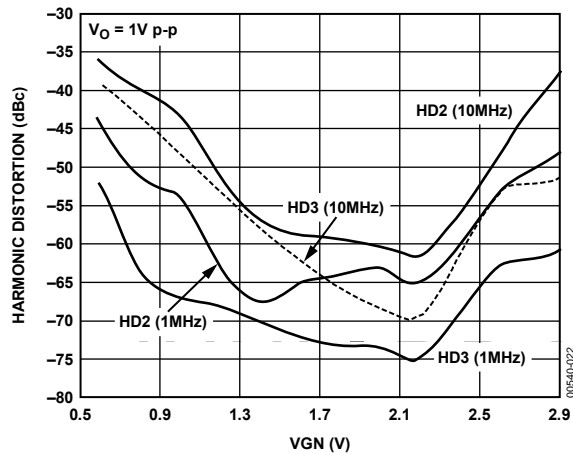


Figure 22. Harmonic Distortion vs. V_{GN}

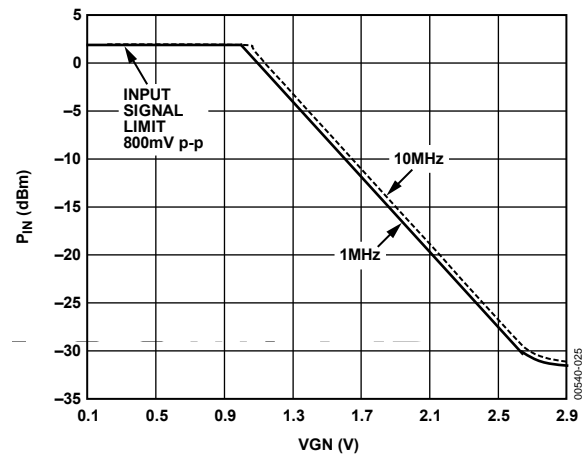


Figure 25. 1 dB Compression vs. V_{GN}

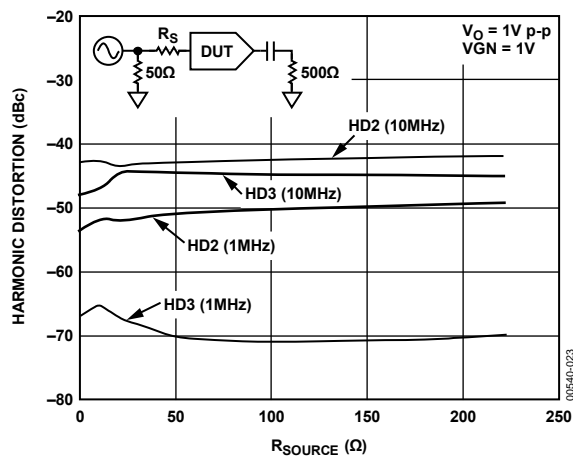


Figure 23. Harmonic Distortion vs. R_{SOURCE}

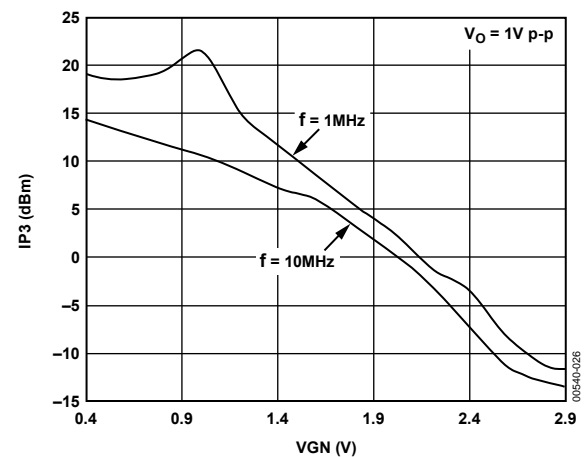


Figure 26. Third-Order Intercept vs. V_{GN}

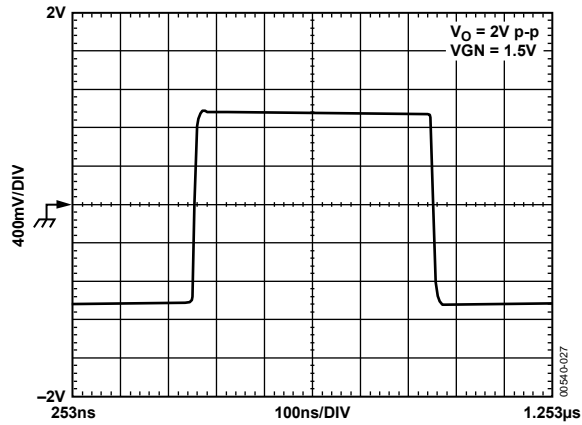


Figure 27. Large Signal Pulse Response

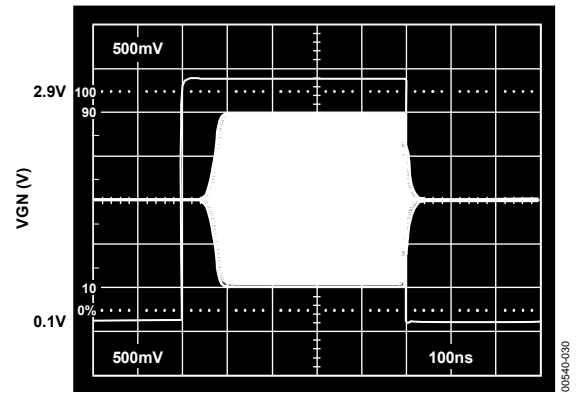


Figure 30. Gain Response

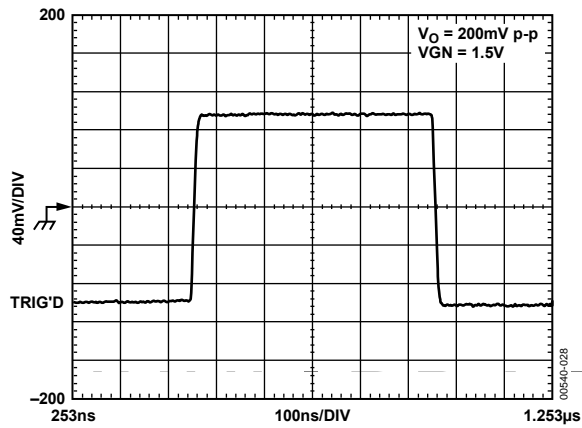


Figure 28. Small Signal Pulse Response

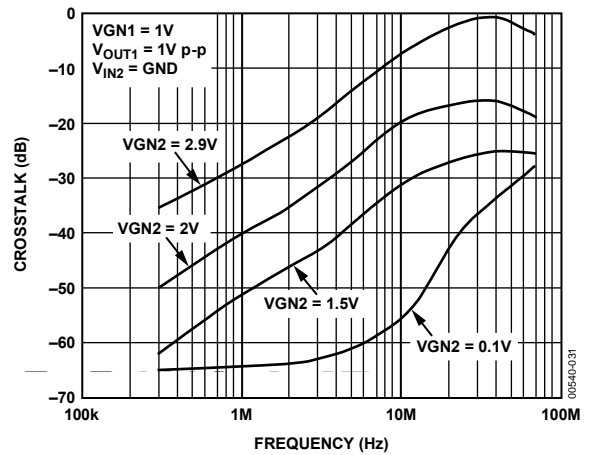


Figure 31. Crosstalk (Channel 1 to Channel 2) vs. Frequency

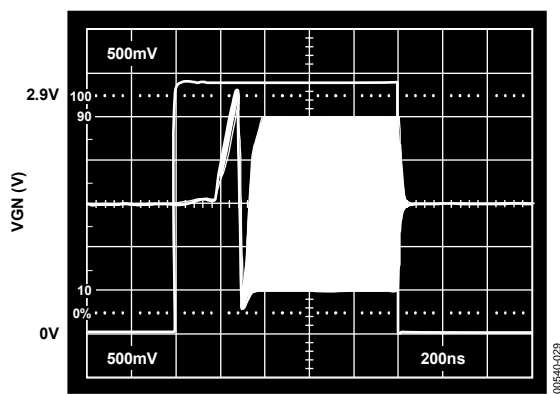


Figure 29. Power-Up/Power-Down Response

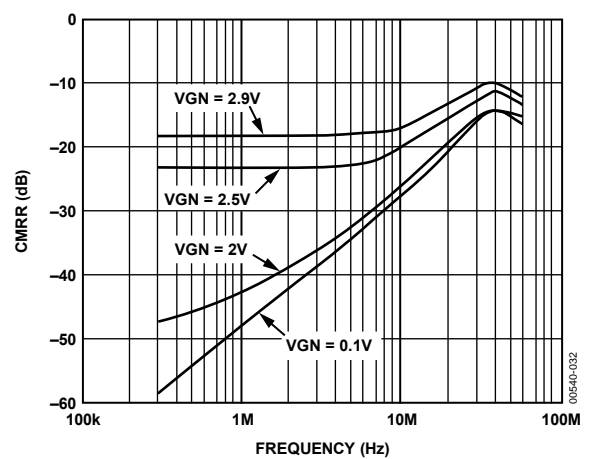


Figure 32. DSX Common-Mode Rejection Ratio vs. Frequency

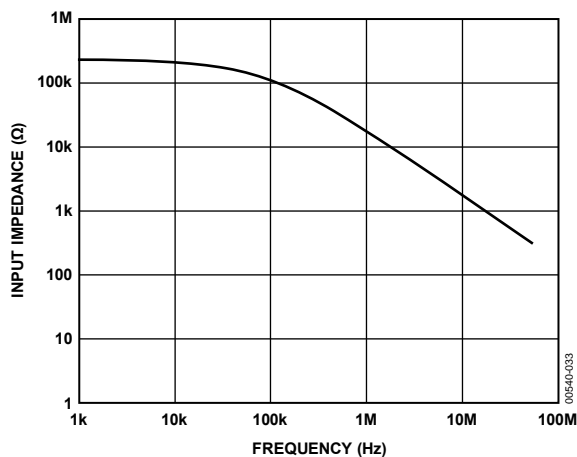


Figure 33. Input Impedance vs. Frequency

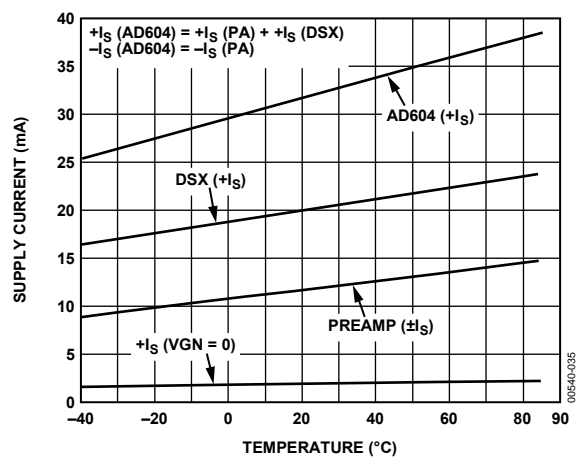


Figure 35. Supply Current (One Channel) vs. Temperature

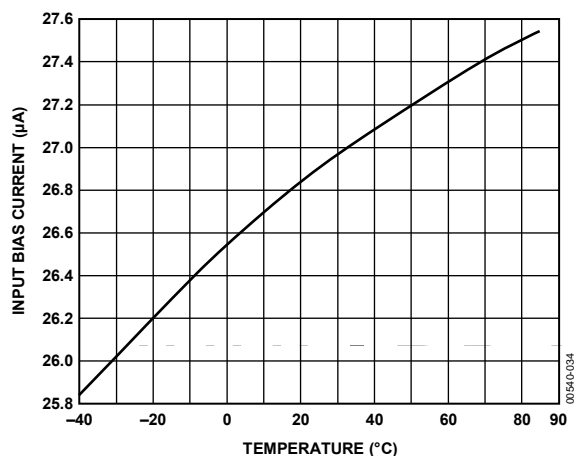


Figure 34. Input Bias Current vs. Temperature

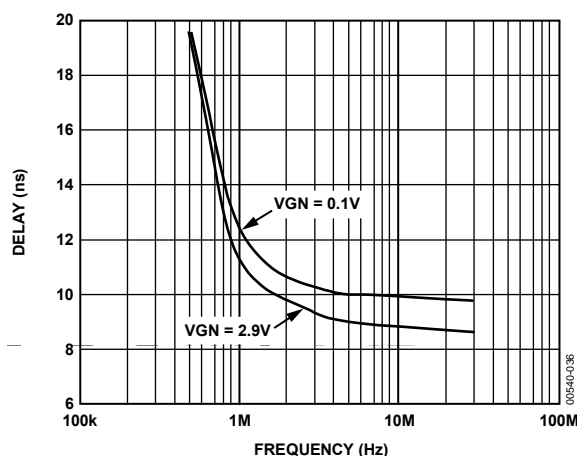


Figure 36. Group Delay vs. Frequency

THEORY OF OPERATION

PREAMPLIFIER

The input capability of the following single-supply DSX (2.5 ± 2 V for a +5 V supply) limits the maximum input voltage of the preamplifier to ± 400 mV for the 14 dB gain configuration or ± 200 mV for the 20 dB gain configuration.

The preamplifier gain can be programmed to 14 dB or 20 dB by either shorting the FBK1 node to PAO1 (14 dB) or by leaving the FBK1 node open (20 dB). These two gain settings are very accurate because they are set by the ratio of the on-chip resistors. Any intermediate gain can be achieved by connecting the appropriate resistor value between PAO1 and FBK1 according to Equation 2 and Equation 3.

$$G = \frac{V_{OUT}}{V_{IN}} = \frac{(R7 \parallel R_{EXT}) + R5 + R6}{R6} \quad (2)$$

$$R_{EXT} = \frac{[R6 \times G - (R5 + R6)] \times R7}{R7 - (R6 \times G) + (R5 + R6)} \quad (3)$$

Because the internal resistors have an absolute tolerance of $\pm 20\%$, the gain can be in error by as much as 0.33 dB when R_{EXT} is 30Ω , where it is assumed that R_{EXT} is exact.

Figure 38 shows how the preamplifier is set to gains of 14 dB, 17.5 dB, and 20 dB. The gain range of a single channel of the AD604 is 0 dB to 48 dB when the preamplifier is set to 14 dB (Figure 38a), 3.5 dB to 51.5 dB for a preamp gain of 17.5 dB (Figure 38b), and 6 dB to 54 dB for the highest preamp gain of 20 dB (Figure 38c).

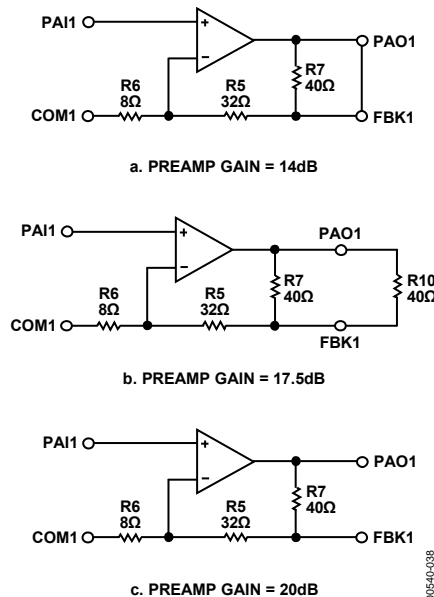


Figure 38. Preamplifier Gain Programmability

For a preamplifier gain of 14 dB, the -3 dB small signal bandwidth of the preamplifier is 130 MHz. When the gain is at its maximum of 20 dB, the bandwidth is reduced by half to 65 MHz. Figure 39 shows the ac response for the three preamp gains shown in Figure 38. Note that the gain for an R_{EXT} of 40Ω should be 17.5 dB, but the mismatch between the internal resistors and the external resistor causes the actual gain for this particular

preamplifier to be 17.7 dB. The -3 dB small signal bandwidth of one complete channel of the AD604 (preamplifier and DSX) is 40 MHz and is independent of gain.

To achieve optimum specifications, power and ground management are critical to the AD604. Large dynamic currents result because of the low resistances needed for the desired noise performance. Most of the difficulty is with the very low gain setting resistors of the preamplifier that allow for a total input referred noise, including the DSX, as low as $0.8 \text{ nV}/\sqrt{\text{Hz}}$. The consequently large dynamic currents have to be carefully handled to maintain performance even at large signal levels.

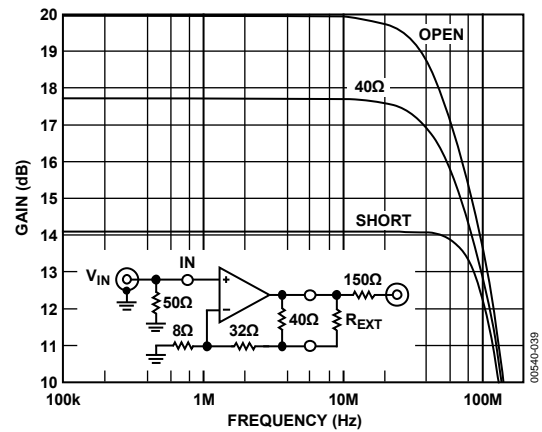


Figure 39. AC Response for Preamplifier Gains of 14 dB, 17.5 dB, and 20 dB

The preamplifier uses a dual ± 5 V supply to accommodate large dynamic currents and a ground referenced input. The preamplifier output is also ground referenced and requires a common-mode level shift into the single-supply DSX. The two external coupling capacitors (C1 and C2 in Figure 37) connected to the PAO1 and +DSXx, and -DSXx, nodes and ground, respectively, perform this function (see the AC Coupling section). In addition, they eliminate any offset that would otherwise be introduced by the preamplifier. It should be noted that an offset of 1 mV at the input of the DSX is amplified by 34.4 dB ($\times 52.5$) when the gain control voltage is at its maximum; this equates to 52.5 mV at the output. AC coupling is consequently required to keep the offset from degrading the output signal range.

The gain-setting preamplifier feedback resistors are small enough (8Ω and 32Ω) that even an additional 1Ω in the ground connection at Pin COM1 (the input common-mode reference) seriously degrades gain accuracy and noise performance. This node is sensitive, and careful attention is necessary to minimize the ground impedance. All connections to the COM1 node should be as short as possible.

The preamplifier, including the gain setting resistors, has a noise performance of $0.71 \text{ nV}/\sqrt{\text{Hz}}$ and $3 \text{ pA}/\sqrt{\text{Hz}}$. Note that a significant portion of the total input referred voltage noise is due to the feedback resistors. The equivalent noise resistance presented by R5 and R6 in parallel is nominally 6.4Ω , which contributes $0.33 \text{ nV}/\sqrt{\text{Hz}}$ to the total input referred voltage noise.

The larger portion of the input referred voltage noise comes from the amplifier with $0.63 \text{ nV}/\sqrt{\text{Hz}}$. The current noise is independent of gain and depends only on the bias current in the input stage of the preamplifier, which is $3 \text{ pA}/\sqrt{\text{Hz}}$.

The preamplifier can drive 40Ω (the nominal feedback resistors) and the following 175Ω ladder load of the DSX with low distortion. For example, at 10 MHz and 1 V at the output, the preamplifier has less than -45 dB of second and third harmonic distortion when driven from a low (25Ω) source resistance.

In applications that require more than 48 dB of gain range, two AD604 channels can be cascaded. Because the preamplifier has a limited input signal range and consumes over half (120 mW) of the total power (220 mW), and its ultralow noise is not necessary after the first AD604 channel, a shutdown mechanism that disables only the preamplifier is provided. To shut down the preamplifier, connect the COM1 pin and/or COM2 pin to the positive supply; the DSX is unaffected. For additional details, refer to the Applications Information section.

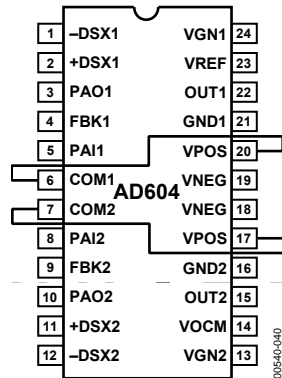


Figure 40. Shutdown of Preamplifiers Only

DIFFERENTIAL LADDER (ATTENUATOR)

The attenuator before the fixed-gain amplifier of the DSX is realized by a differential 7-stage R - $1.5R$ resistive ladder network with an untrimmed input resistance of 175Ω single-ended or 350Ω differential. The signal applied at the input of the ladder network is attenuated by 6.908 dB per tap; thus, the attenuation at the first tap is 0 dB , at the second, 13.816 dB , and so on, all the way to the last tap where the attenuation is 48.356 dB (see Figure 41).

A unique circuit technique is used to interpolate continuously among the tap points, thereby providing continuous attenuation from 0 dB to -48.36 dB . The ladder network, together with the interpolation mechanism, can be considered a voltage-controlled potentiometer.

Because the DSX circuit uses a single voltage power supply, the input biasing is provided by the VOCM buffer driving the MID node (see Figure 41). Without internal biasing, the user would have to dc bias the inputs externally. If not done carefully, the biasing network can introduce additional noise and offsets. By providing internal biasing, the user is relieved of this task and only needs to ac-couple the signal into the DSX. Note that the input to the DSX is still fully differential if driven differentially; that is, Pin $+DSXx$ and Pin $-DSXx$ see the same signal but with opposite polarity (see the Ultralow Noise, Differential Input-Differential Output VGA section).

What changes is the load seen by the driver; it is 175Ω when each input is driven single-ended but 350Ω when driven differentially. This is easily explained by thinking of the ladder network as two 175Ω resistors connected back-to-back with the middle node, MID, being biased by the VOCM buffer. A differential signal applied between the $+DSXx$ and $-DSXx$ nodes results in zero current into the MID node, but a single-ended signal applied to either input, $+DSXx$ or $-DSXx$, while the other input is ac-grounded causes the current delivered by the source to flow into the VOCM buffer via the MID node.

The ladder resistor value of 175Ω provides the optimum balance between the load driving capability of the preamplifier and the noise contribution of the resistors. An advantage of the X-AMP architecture is that the output referred noise is constant vs. gain over most of the gain range. Figure 41 shows that the tap resistance is equal for all taps after only a few taps away from the inputs. The resistance seen looking into each tap is 54.4Ω , which makes $0.95 \text{ nV}/\sqrt{\text{Hz}}$ of Johnson noise spectral density. Because there are two attenuators, the overall noise contribution of the ladder network is $\sqrt{2}$ times $0.95 \text{ nV}/\sqrt{\text{Hz}}$ or $1.34 \text{ nV}/\sqrt{\text{Hz}}$, a large fraction of the total DSX noise. The balance of the DSX circuit components contributes another $1.2 \text{ nV}/\sqrt{\text{Hz}}$, which together with the attenuator produces $1.8 \text{ nV}/\sqrt{\text{Hz}}$ of total DSX input referred noise.

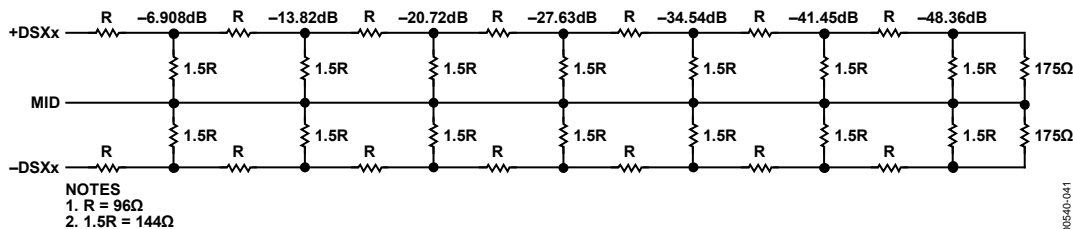


Figure 41. R-1.5R Dual Ladder Network

AC COUPLING

The DSX portion of the AD604 is a single-supply circuit and, therefore, its inputs need to be ac-coupled to accommodate ground-based signals. External Capacitors C1 and C2 in Figure 37 level shift the ground referenced preamplifier output from ground to the dc value established by VOCM (nominal 2.5 V). C1 and C2, together with the 175 Ω looking into each of the DSX inputs (+DSXx and -DSXx), act as high-pass filters with corner frequencies depending on the values chosen for C1 and C2. As an example, for values of 0.1 μ F at C1 and C2, combined with the 175 Ω input resistance at each side of the differential ladder of the DSX, the -3 dB high-pass corner is 9.1 kHz.

If the AD604 output needs to be ground referenced, another ac coupling capacitor is required for level shifting. This capacitor also eliminates any dc offsets contributed by the DSX. With a nominal load of 500 Ω and a 0.1 μ F coupling capacitor, this adds a high-pass filter with -3 dB corner frequency at about 3.2 kHz.

The choice for all three of these coupling capacitors depends on the application. They should allow the signals of interest to pass unattenuated while, at the same time, they can be used to limit the low frequency noise in the system.

GAIN CONTROL INTERFACE

The gain control interface provides an input resistance of approximately 2 M Ω at VGN1 and gain scaling factors from 20 dB/V to 40 dB/V for VREF input voltages of 2.5 V to 1.25 V, respectively. The gain scales linearly in decibels for the center 40 dB of gain range, which for VGN is equal to 0.4 V to 2.4 V for the 20 dB/V scale and 0.2 V to 1.2 V for the 40 dB/V scale. Figure 42 shows the ideal gain curves for a nominal preamplifier gain of 14 dB, which are described by the following equations:

$$G(20 \text{ dB/V}) = 20 \times VGN - 5, VREF = 2.500 \text{ V} \quad (4)$$

$$G(20 \text{ dB/V}) = 30 \times VGN - 5, VREF = 1.666 \text{ V} \quad (5)$$

$$G(20 \text{ dB/V}) = 40 \times VGN - 5, VREF = 1.250 \text{ V} \quad (6)$$

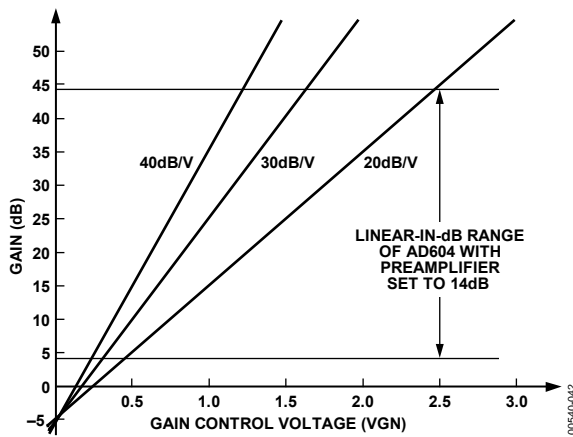


Figure 42. Ideal Gain Curves vs. VGN

From these equations, it can be seen that all gain curves intercept at the same -5 dB point; this intercept is +6 dB higher (+1 dB) if the preamplifier gain is set to +20 dB or +14 dB lower (-19 dB) if the preamplifier is not used at all. Outside the central linear range, the gain starts to deviate from the ideal control law but still provides another 8.4 dB of range. For a given gain scaling, V_{REF} can be calculated as shown in Equation 7.

$$V_{REF} = \frac{2.500 \text{ V} \times 20 \text{ dB/V}}{\text{Gain Scale}} \quad (7)$$

Usable gain control voltage ranges are 0.1 V to 2.9 V for the 20 dB/V scale and 0.1 V to 1.45 V for the 40 dB/V scale. VGN voltages of less than 0.1 V are not used for gain control because below 50 mV the channel (preamplifier and DSX) is powered down. This can be used to conserve power and, at the same time, to gate off the signal. The supply current for a powered-down channel is 1.9 mA; the response time to power the device on or off is less than 1 μ s.

ACTIVE FEEDBACK AMPLIFIER (FIXED-GAIN AMP)

To achieve single-supply operation and a fully differential input to the DSX, an active feedback amplifier (AFA) is used. The AFA is an op amp with two g_m stages; one of the active stages is used in the feedback path (therefore the name), while the other is used as a differential input. Note that the differential input is an open-loop g_m stage that requires it to be highly linear over the expected input signal range. In this design, the g_m stage that senses the voltages on the attenuator is a distributed one; for example, there are as many g_m stages as there are taps on the ladder network. Only a few of them are on at any one time, depending on the gain control voltage.

The AFA makes a differential input structure possible because one of its inputs (G1) is fully differential; this input is made up of a distributed g_m stage. The second input (G2) is used for feedback. The output of G1 is some function of the voltages sensed on the attenuator taps, which is applied to a high-gain amplifier (A0). Because of negative feedback, the differential input to the high-gain amplifier has to be zero; this in turn implies that the differential input voltage to G2 times g_{m2} (the transconductance of G2) has to be equal to the differential input voltage to G1 times g_{m1} (the transconductance of G1).

Therefore, the overall gain function of the AFA is

$$\frac{V_{OUT}}{V_{ATTEN}} = \frac{g_{m1}}{g_{m2}} \times \frac{R1 + R2}{R2} \quad (8)$$

where:

V_{OUT} is the output voltage.

V_{ATTEN} is the effective voltage sensed on the attenuator.

$$(R1 + R2)/R2 = 42$$

$$g_{m1}/g_{m2} = 1.25$$

The overall gain is thus 52.5 (34.4 dB).

The AFA offers the following additional features:

- The ability to invert the signal by switching the positive and negative inputs to the ladder network
- The possibility of using DSX1 input as a second signal input
- Fully differential high-impedance inputs when both preamplifiers are used with one DSX (the other DSX could still be used alone)
- Independent control of the DSX common-mode voltage

Under normal operating conditions, it is best to connect a decoupling capacitor to VOCM, in which case, the common-mode voltage of the DSX is half the supply voltage, which allows for maximum signal swing. Nevertheless, the common-mode voltage can be shifted up or down by directly applying a voltage to VOCM. It can also be used as another signal input, the only limitation being the rather low slew rate of the VOCM buffer.

If the dc level of the output signal is not critical, another coupling capacitor is normally used at the output of the DSX; again, this is done for level shifting and to eliminate any dc offsets contributed by the DSX (see the AC Coupling section).

APPLICATIONS INFORMATION

The basic circuit in Figure 43 shows the connections for one channel of the AD604. The signal is applied at Pin 5. RGN is normally 0, in which case the preamplifier is set to a gain of 5 (14 dB). When FBK1 is left open, the preamplifier is set to a gain of 10 (20 dB), and the gain range shifts up by 6 dB. The ac coupling capacitors before –DSX1 and +DSX1 should be selected according to the required lower cutoff frequency. In this example, the 0.1 μ F capacitors, together with the 175 Ω seen looking into each of the DSXx input pins, provide a –3 dB high-pass corner of about 9.1 kHz. The upper cutoff frequency is determined by the bandwidth of the channel, which is 40 MHz. Note that the signal can be simply inverted by connecting the output of the preamplifier to –DSX1 instead of +DSX1; this is due to the fully differential input of the DSX.

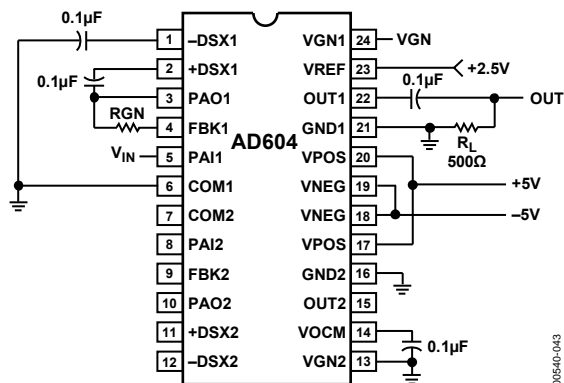


Figure 43. Basic Connections for a Single Channel

In Figure 43, the output is ac-coupled for optimum performance. For dc coupling, as shown in Figure 52, the capacitor can be eliminated if VOCM is biased at the same 3.3 V common-mode voltage as the analog-to-digital converter, [AD9050](#).

VREF requires a voltage of 1.25 V to 2.5 V, with between 40 dB/V and 20 dB/V gain scaling, respectively. Voltage VGN controls the gain; its nominal operating range is from 0.25 V to 2.65 V for 20 dB/V gain scaling and 0.125 V to 1.325 V for 40 dB/V scaling. When VGNx is grounded, the channel powers down and disables its output.

COM1 is the main signal ground for the preamplifier and needs to be connected with as short a connection as possible to the input ground. Because the internal feedback resistors of the preamplifier are very small for noise reasons (8 Ω and 32 Ω nominally), it is of utmost importance to keep the resistance in this connection to a minimum. Furthermore, excessive inductance in this connection can lead to oscillations.

Because of the ultralow noise and wide bandwidth of the AD604, large dynamic currents flow to and from the power supply. To ensure the stability of the part, careful attention to supply decoupling is required. A large storage capacitor in parallel with a smaller high-frequency capacitor connected at the supply pins, together with a ferrite bead coming from the supply, should be used to ensure high-frequency stability.

To provide for additional flexibility, COM1 can be used to disable the preamplifier. When COM1 is connected to VP, the preamplifier is off, yet the DSX portion can be used independently. This may be of value when cascading the two DSX stages in the AD604. In this case, the first DSX output signal with respect to noise is large and using the second preamplifier at this point would waste power (see Figure 44).

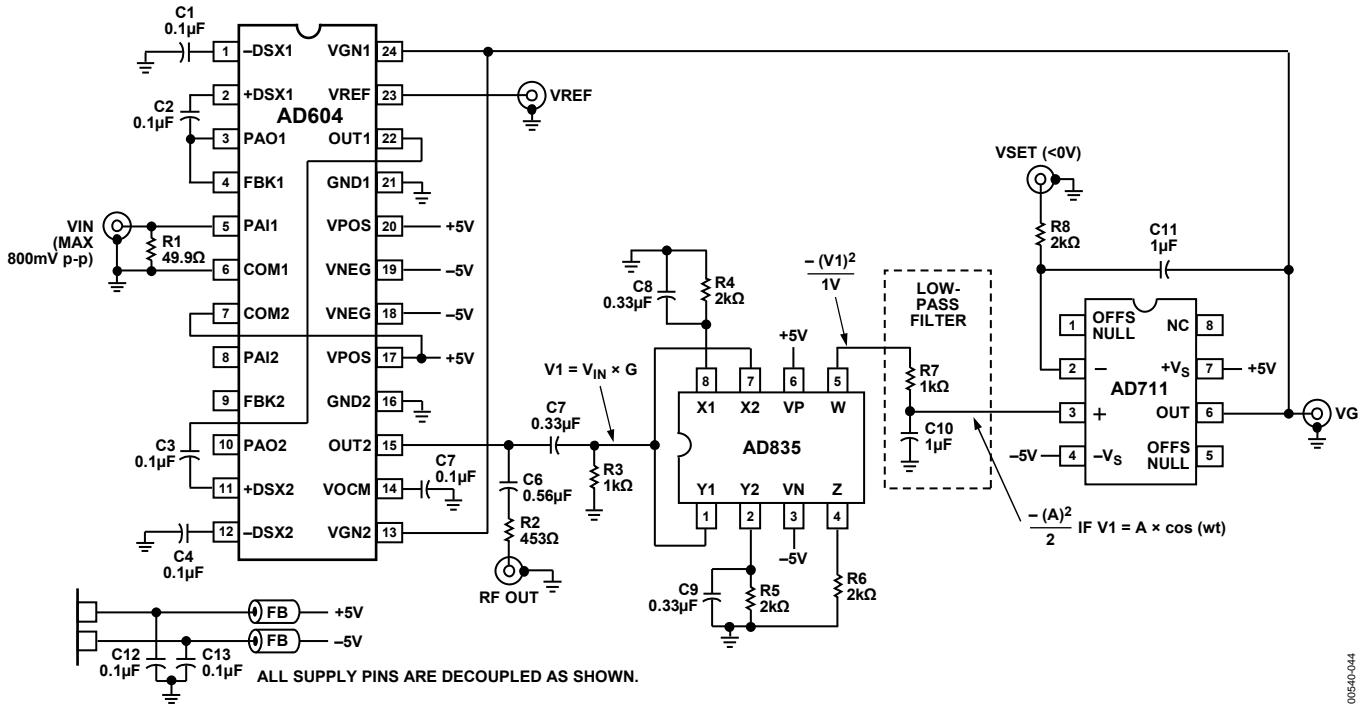


Figure 44. AGC Amplifier with 82 dB of Gain Range

ULTRALOW NOISE AGC AMPLIFIER WITH 82 dB TO 96 dB GAIN RANGE

Figure 44 shows an implementation of an AGC amplifier with 82 dB of gain range using a single AD604. The signal is applied to connector VIN and, because the signal source is 50 Ω, a terminating resistor (R1) of 49.9 Ω is added. The signal is then amplified by 14 dB (Pin FBK1 shorted to PAO1) through the Channel 1 preamplifier and is further processed by the Channel 1 DSX. Next, the signal is applied directly to the Channel 2 DSX. The second preamplifier is powered down by connecting its COM2 pin to the positive supply as explained in the Preamplifier section.

C1 and C2 level shift the signal from the preamplifier into the first DSX and, at the same time, eliminate any offset contribution of the preamplifier. C3 and C4 have the same offset cancellation purpose for the second DSX. Each set of capacitors, combined with the 175 Ω input resistance of the corresponding DSX, provides a high-pass filter with a -3 dB corner frequency of about 9.1 kHz. VOCM is decoupled to ground by a 0.1 μF capacitor, while VREF can be externally provided; in this application, the gain scale is set to 20 dB/V by applying 2.500 V. Because each DSX amplifier operates from a single 5 V supply, the output is ac-coupled via C6 and C7. The output signal can be monitored at the connector labeled RF OUT.

Figure 45 and Figure 46 show the gain range and gain error for the AD604 connected as shown in Figure 44. The gain range is -14 dB to +82 dB; the useful range is 0 dB to +82 dB if the RF output amplitude is controlled to ±400 mV (+2 dBm). The main limitation on the lower end of the signal range is the input capability of the preamplifier. This limitation can be overcome by adding an attenuator in front of the preamplifier, but that would defeat the advantage of the ultralow noise preamplifier. It should be noted that the second preamplifier is not used because its ultralow noise and the associated high-power consumption are overkill after the first DSX stage. It is disabled in this application by connecting the COM2 pin to the positive supply. Nevertheless, the second preamplifier can be used, if so desired, and the useful gain range increases by 14 dB to encompass 0 dB to 96 dB of gain. For the same +2 dBm output, this allows signals as small as -94 dBm to be measured.

To achieve the highest gains, the input signal must be band-limited to reduce the noise; this is especially true if the second preamplifier is used. If the maximum signal at OUT2 of the AD604 is limited to ±400 mV (+2 dBm), the input signal level at the AGC threshold is +25 μV rms (-79 dBm). The circuit as shown in Figure 44 has about 40 MHz of noise bandwidth; the 0.8 nV/√Hz of input referred voltage noise spectral density of the AD604 results in an rms noise of 5.05 μV in the 40 MHz bandwidth.

The 50 Ω termination resistor, in parallel with the 50 Ω source resistance of the signal generator, forms an effective resistance of 25 Ω as seen by the input of the preamplifier, creating 4.07 μV of rms noise at a bandwidth of 40 MHz. The noise floor of this channel is consequently 6.5 μV rms, the rms sum of these two main noise sources. The minimum detectable signal (MDS) for this circuit is +6.5 μV rms (–90.7 dBm). Generally, the measured signal should be about a factor of three larger than the noise floor, in this case 19.5 μV rms. Note that the 25 μV rms signal that this AGC circuit can correct for is just slightly above the MDS. Of course, the sensitivity of the input can be improved by band-limiting the signal; if the noise bandwidth is reduced by a factor of four to 10 MHz, the noise floor of the AGC circuit with a 50 Ω termination resistor drops to +3.25 μV rms (–96.7 dBm). Further noise improvement can be achieved by an input matching network or by transformer coupling of the input signal.

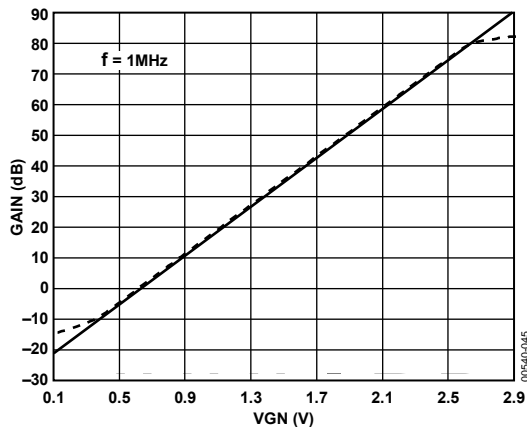


Figure 45. Cascaded Gain vs. VGN (Based on Figure 44)

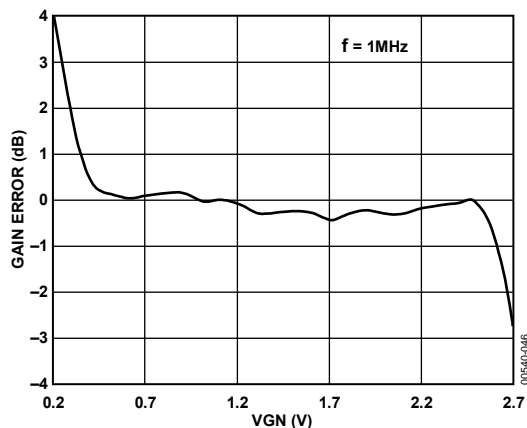


Figure 46. Cascaded Gain Error vs. VGN (Based on Figure 44)

The descriptions of the detector circuitry functions, comprising a squarer, a low-pass filter, and an integrator, follow. At this point, it is necessary to make some assumptions about the input signal. The following explanation of the detector circuitry presumes an amplitude modulated RF carrier where the modulating signal is at a much lower frequency than the RF signal. The AD835 multiplier functions as the detector by squaring the output signal presented to it by the AD604. A low-pass filter following the squaring operation removes the RF signal component at twice

the incoming signal frequency, while passing the low frequency AM information. The following integrator with a time constant of 2 ms set by R8 and C11 integrates the error signal presented by the low-pass filter and changes VG until the error signal is equal to V_{SET} .

For example, if the signal presented to the detector is $V_1 = A \times \cos(\omega t)$ as indicated in Figure 44, the output of the squarer is $-(V_1)^2/1 \text{ V}$. The reason for all the minus signs in the detection circuitry is the necessity of providing negative feedback in the control loop; actually, if V_{SET} becomes greater than 0 V, the control loop provides positive feedback. Squaring $A \times \cos(\omega t)$ results in two terms, one at dc and one at 2ω ; the following low-pass filter passes only the $-(A)^2/2$ dc term. This dc voltage is now forced equal to the voltage, V_{SET} , by the control loop. The squarer, together with the low-pass filter, functions as a mean-square detector. As should be evident by controlling the value of V_{SET} , the amplitude of the voltage V_1 can be set at the input of the AD835; if V_{SET} equals –80 mV, the AGC output signal amplitude is $\pm 400 \text{ mV}$.

Figure 47 shows the control voltage, VGN, vs. the input power at frequencies of 1 MHz (solid line) and 10 MHz (dashed line) at an output regulated level of 2 dBm (800 mV p-p). The AGC threshold is evident at a P_{IN} of about –79 dBm; the highest input power that can still be accommodated is about +3 dBm. At this level, the output starts being distorted because of clipping in the preamplifier.

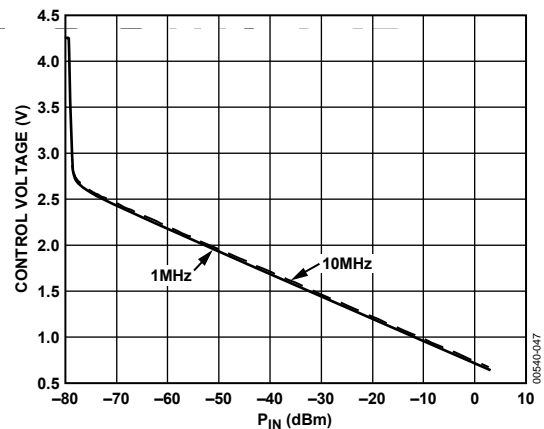


Figure 47. Control Voltage vs. Input Power of the Circuit in Figure 44

As previously mentioned, the second preamplifier can be used to extend the range of the AGC circuit in Figure 44. Figure 48 shows the modifications that must be made to Figure 46 to achieve 96 dB of gain and dynamic range. Because of the extremely high gain, the bandwidth must be limited to reject some of the noise. Furthermore, limiting the bandwidth helps suppress high-frequency oscillations. The added components act as a low-pass filter and dc block (C5 decouples the 2.5 V common-mode output of the first DSX). The ferrite bead has an impedance of about 5 Ω at 1 MHz, 30 Ω at 10 MHz, and 70 Ω at 100 MHz. The bead, combined with R2 and C6, forms a 1 MHz low-pass filter.

At 1 MHz, the attenuation is about -0.2 dB, increasing to -6 dB at 10 MHz and -28 dB at 100 MHz. Signals less than approximately 1 MHz are not significantly affected.

Figure 49 shows the control voltage vs. the input power at 1 MHz to the circuit shown in Figure 48; note that the AGC threshold is at -95 dBm. The output signal level is set to 800 mV p-p by applying -80 mV to the V_{SET} connector.

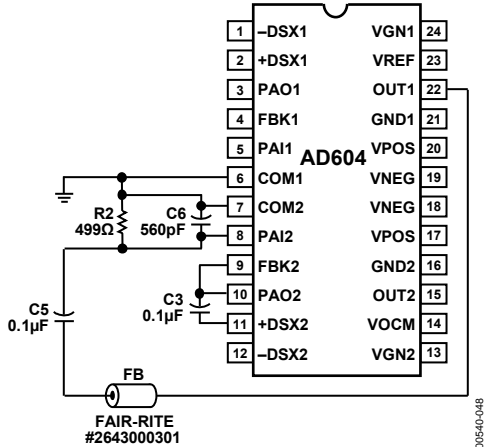


Figure 48. Modifications of the AGC Amplifier to Create 96 dB of Gain Range

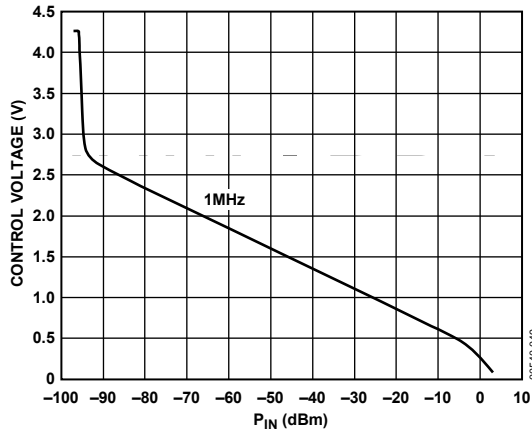


Figure 49. Control Voltage vs. Input Power of the Circuit in Figure 48

ULTRALOW NOISE, DIFFERENTIAL INPUT-DIFFERENTIAL OUTPUT VGA

Figure 50 shows how to use both preamplifiers and DSXs to create a high impedance, differential input-differential output VGA. This application takes advantage of the differential inputs to the DSXs. Note that the input is not truly differential in the sense that the common-mode voltage needs to be at ground to achieve maximum input signal swing. This has largely to do with the limited output swing capability of the output drivers of the preamplifiers; they clip around ± 2.2 V due to having to drive an effective load of about 30Ω . If a different input common-mode voltage needs to be accommodated, ac coupling (as in Figure 48) is recommended. The differential gain range of this circuit runs from 6 dB to 54 dB, which is 6 dB higher than each individual channel of the AD604 because the DSX inputs now see twice

the signal amplitude compared with when they are driven single-ended.

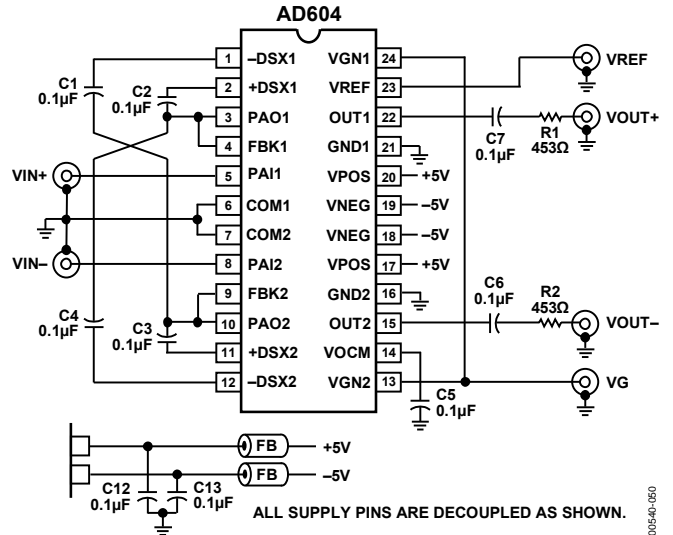
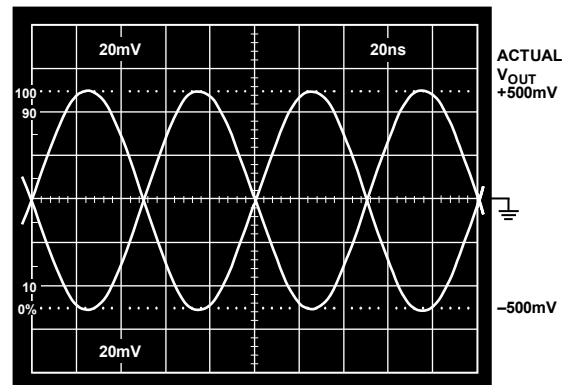


Figure 50. Ultralow Noise, Differential Input-Differential Output VGA

Figure 51 displays the output signals V_{OUT+} and V_{OUT-} after a -20 dB attenuator formed between the 453Ω resistors shown in Figure 50 and the 50Ω loads presented by the oscilloscope plug-in. $R1$ and $R2$ are inserted to ensure a nominal load of 500Ω at each output. The differential gain of the circuit is set to 20 dB by applying a control voltage, V_{GN} , of 1 V; the gain scaling is 20 dB/V for a V_{REF} of 2.500 V; the input frequency is 10 MHz, and the differential input amplitude is 100 mV p-p. The resulting differential output amplitude is 1 V p-p as can be seen on the scope photo when reading the vertical scale as 200 mV/div.



NOTES
1. THE OUTPUT AFTER $10\times$ ATTENUATOR FORMED BY 453Ω TOGETHER WITH 50Ω OF 7A24 PLUG-IN.

Figure 51. Output of VGA in Figure 50 for $V_{GN} = 1$ V

AD604

MEDICAL ULTRASOUND TGC DRIVING THE AD9050, A 10-BIT, 40 MSPS ADC

The AD604 is an ideal candidate for the time gain control (TGC) amplifier that is required in medical ultrasound systems to limit the dynamic range of the signal that is presented to the ADC.

Figure 52 shows a schematic of an AD604 driving an AD9050 in a typical medical ultrasound application.

The gain is controlled by means of a digital byte that is input to an AD7226 DAC that outputs the analog gain control signal. The output common-mode voltage of the AD604 is set to $V_{POS}/2$ by means of an internal voltage divider. The VOCM pin is bypassed with a 0.1 μF capacitor to ground.

The DSX output is optionally filtered and then buffered by an AD9631 op amp, a low distortion, low noise amplifier. The op amp output is ac-coupled into the self-biasing input of an AD9050 ADC that is capable of outputting 10 bits at a 40 MSPS sampling rate.

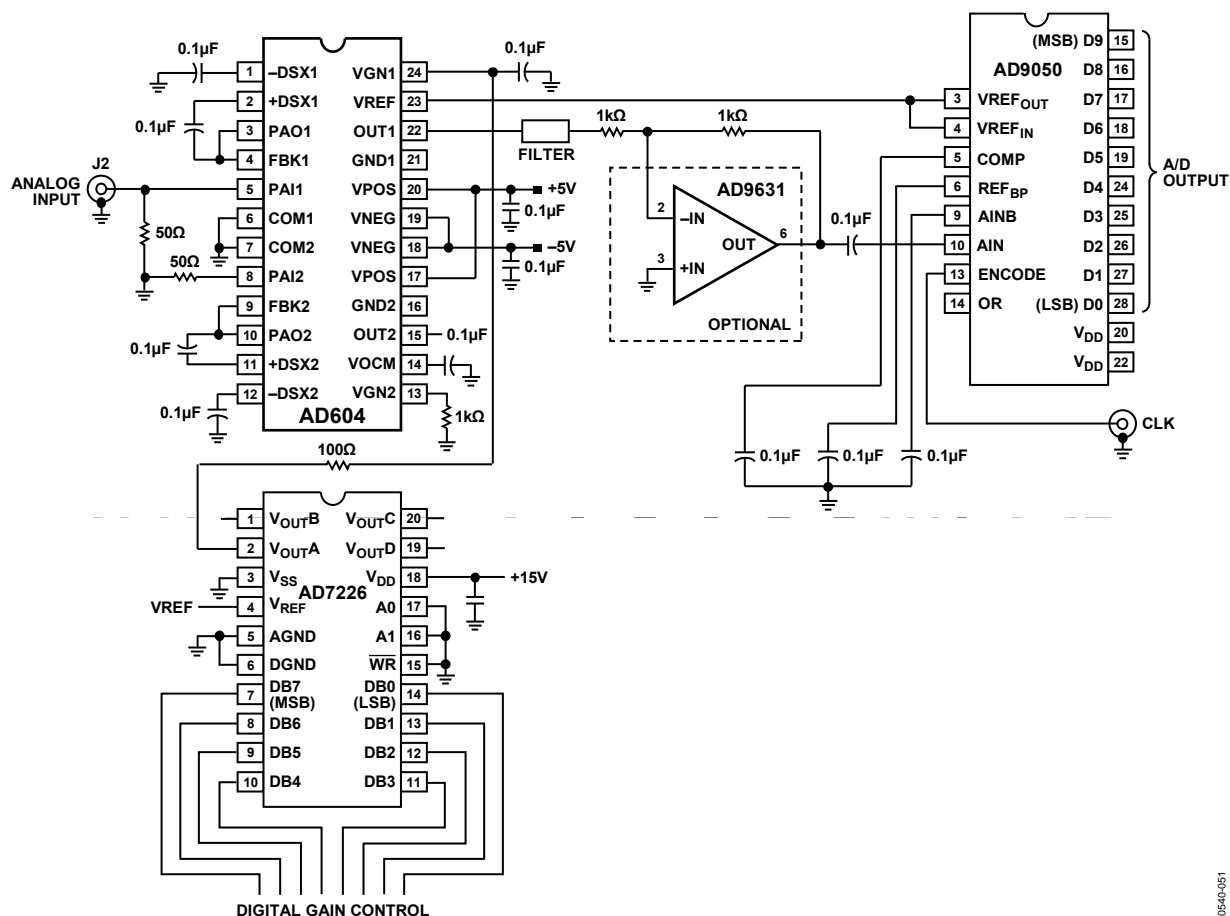
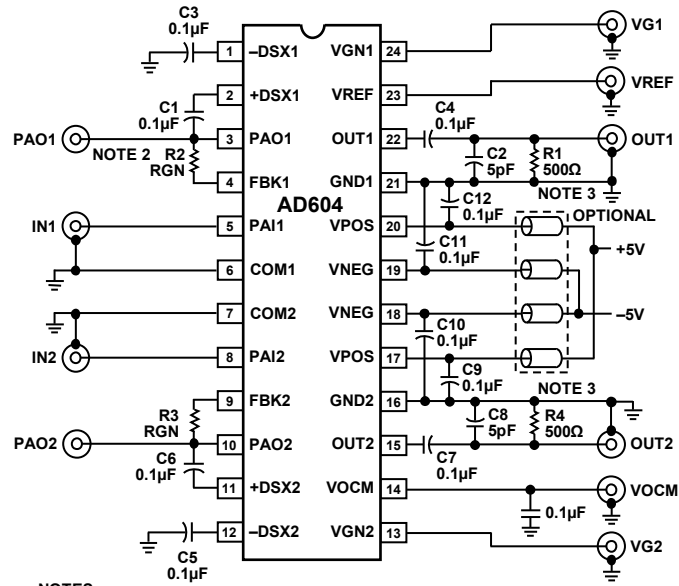


Figure 52. TGC Circuit for Medical Ultrasound Application

00540-051



- NOTES**
 1. PAO1 AND PAO2 ARE USED TO MEASURE PREAMPS.
 2. RGN = 0 NOMINALLY; PREAMP GAIN = 5, RGN = OPEN; PREAMP GAIN = 10.
 3. WHEN MEASURING BW WITH 50Ω SPECTRUM ANALYZER, USE 450Ω IN SERIES.

Figure 53. Basic Test Board

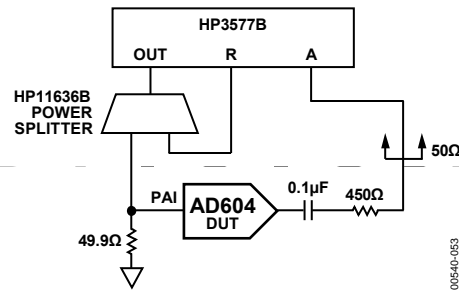


Figure 54. Setup for Gain Measurements

EVALUATION BOARD

Figure 55 is a photograph of the AD604 evaluation board assembly. Multiple input connections, test points, jumper selectable options, and on-board trims offer convenience when configuring the AD604 in various operating modes.

The evaluation board requires only a dual 5 V supply capable of 200 mA or higher to operate both channels. Prior to shipment, the evaluation board is fully tested. Users need only attach power supply leads and the appropriate test equipment to the board.

Because of this flexibility, not all component positions on the board are populated when the board is shipped. Installing or changing additional parts is optional.

The AD604-EVALZ is fabricated on a 4-layer board with inner power and ground layers. The AD604 is a stable, trouble-free device; however, as with all high-frequency integrated circuits, power and ground planes help to ensure consistency in performance.



Figure 55. AD604 Evaluation Board Assembly

USING THE PREAMPLIFIER

To use the preamplifiers, simply connect a signal source to CH1 PREAMP IN and/or CH2 PREAMP IN via the SMA connectors. Referring to the schematic in Figure 61, the input lines are terminated with 50 Ω resistors at locations R7 and R8.

To enable the preamplifiers, insert jumpers in the JP8 and JP9 rightmost positions; this connects COM1 and COM2 to ground. Power down the preamplifiers by inserting jumpers in the JP8 and JP9 leftmost positions.

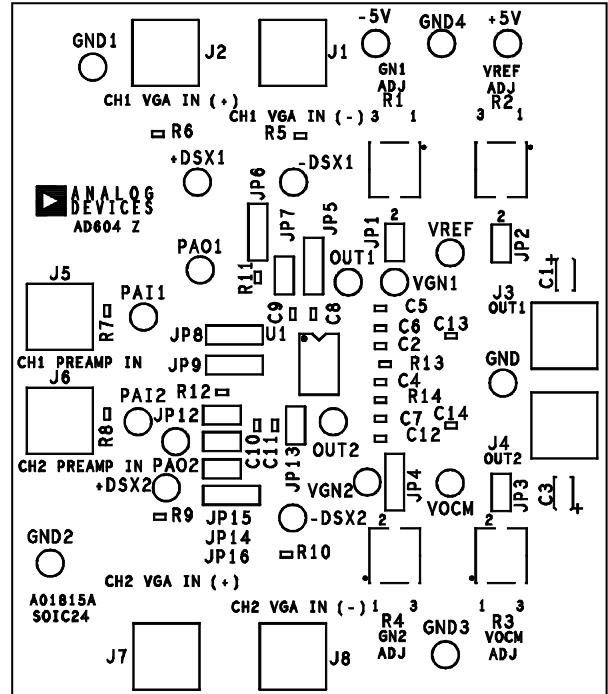


Figure 56. AD604 Evaluation Board—Component Side Silk Screen

DSX INPUT CONNECTIONS

The DSX inputs can be connected in single-ended or differential configurations. SMA connectors are provided for each of the inputs and are labeled CHx VGA IN (+) and CHx VGA IN (-). JP6 and JP15 select between the preamplifier outputs and the DSX inputs.

For direct drive of the Channel 1 VGA, insert a jumper in the top position of JP6. For direct drive of the Channel 2 VGA, insert a jumper in JP14 and verify that there are no jumpers in JP12 and JP13. Refer to the schematic shown in Figure 61 for circuit details.

Differential DSX Inputs

Differential inputs are possible using both polarities of the VGA SMA connectors and appropriate jumpers. Inserting a jumper in the lower position of JP5 selects the negative input of Channel 1. A jumper in the top position of JP6 selects the positive input of Channel 1. A jumper in the JP16 rightmost position selects the negative input of Channel 2, and a jumper in JP14 selects the positive input. Verify that there are no jumpers in JP15 or JP13.

Because the VGA section of the AD604 uses a single 5 V supply, the DSX inputs are ac-coupled. Decoupling capacitors are provided on the evaluation board.

The DSX input impedance is approximately 200 Ω . Optional 66.5 Ω resistors can be installed across the inputs at positions R5, R6, R9, and R10 to establish a 50 Ω terminating load.

Connecting the DSX Inputs to the Preamplifiers

To connect the DSX inputs to the preamplifiers, install jumpers in the JP6 lower position and in JP15. Verify that the jumpers in JP13 and JP14 are removed.

Cascaded DSX

To channel-cascade the two channels, insert a jumper in JP13. The resulting single-channel gain range is 96 dB. Verify that JP14 and JP15 are removed.

The gains of cascaded VGAs can be controlled independently or in common. For common control, insert a jumper in the top position of JP4. To use the trimmer as a gain control, insert a jumper in JP1. For external control, remove JP1 and connect a signal source at VGN1 or VGN2 test loop.

PREAMPLIFIER GAIN

Jumpers in JP7 and JP12 select between two preamplifier gains: 14 dB and 20 dB. Intermediate gains are derived by installing resistors in the R11 and R12 positions. The 14 dB and 20 dB preset gains are accurate due to close matching of thin film resistors. The gain accuracy after installing external resistors is subject to inherent tolerance of absolute accuracy.

OUTPUTS

The DSX outputs are available on OUT1 and OUT2 SMA connectors and are series terminated with decoupling capacitors and 49.9 Ω series resistors. These components can be replaced to accommodate other output impedances.

DC OPERATING CONDITIONS

Table 4 lists the trimmers and their functions provided for convenient dc level adjustments of gain, reference voltage, and output common-mode voltage. Table 5 lists the jumpers and their functions.

Table 4. Trimmer Functions

Trimmer	Function
R1	Gain of Channel 1
R2	Reference voltage adjustment
R3	Output common-mode voltage adjustment
R4	Channel 2 gain adjustment

Table 5. Jumpers

Jumper No.	Function
1	Connects R1 gain adjust wiper to VGN1.
2	Connects R2 reference voltage trimmer to VREF input.
3	Connects common-mode voltage trimmer to VOCM.
4	Connects VGN2 to R4 Channel 2 gain trimmer or to VGN1 or common gain adjustment.
5	Connects –DSX1 to CH1 VGA IN (–) or to ground.
6	Connects +DSX1 (ac-coupled) to preamplifier output of Channel 1 or to the CH 1 VGA IN (+) SMA connector.
7	When open, the Preamp 1 gain is 20 dB; Preamp 1 gain is 14 dB when a shunt is installed.
8	Shunt in left position disables Preamp 1; shunt in rightmost position enables Preamp 1.
9	Shunt in left position disables Preamp 2; shunt in rightmost position enables Preamp 2.
12	When open, the Preamp 2 gain is 20 dB; Preamp 2 gain is 14 dB when a shunt is installed.
13	Cascades DSX2 with DSX 1 when a jumper is inserted.
14	Connects +DSX2 (ac-coupled) to preamplifier output of Channel 2 or to the CH 2 VGA IN (+) SMA connector.
15	Connects +DSX2 (ac-coupled) to preamplifier output of Channel 2.
16	Connects –DSX2 to CH2 VGA IN (–) or to ground.

EVALUATION BOARD ARTWORK AND SCHEMATIC

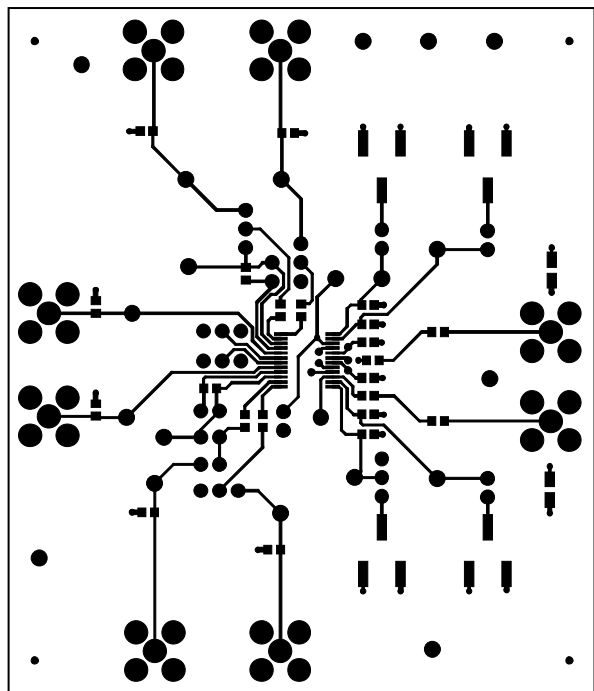


Figure 57. Component Side Copper

00540-057

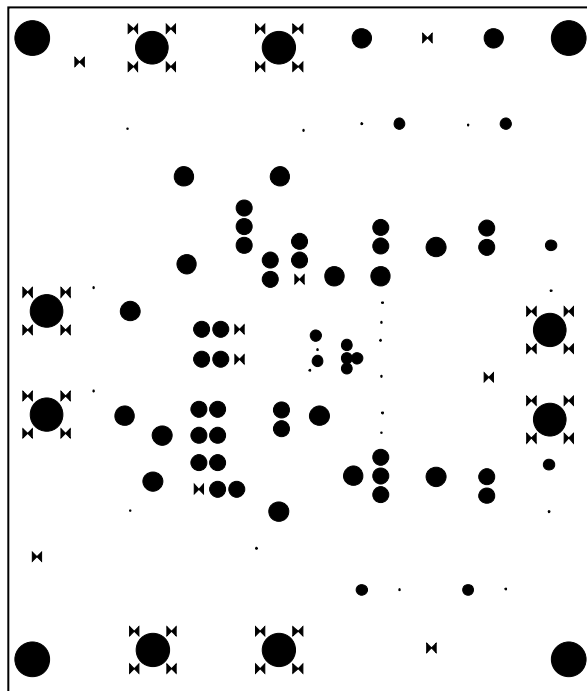


Figure 59. Internal Ground Plane

00540-059

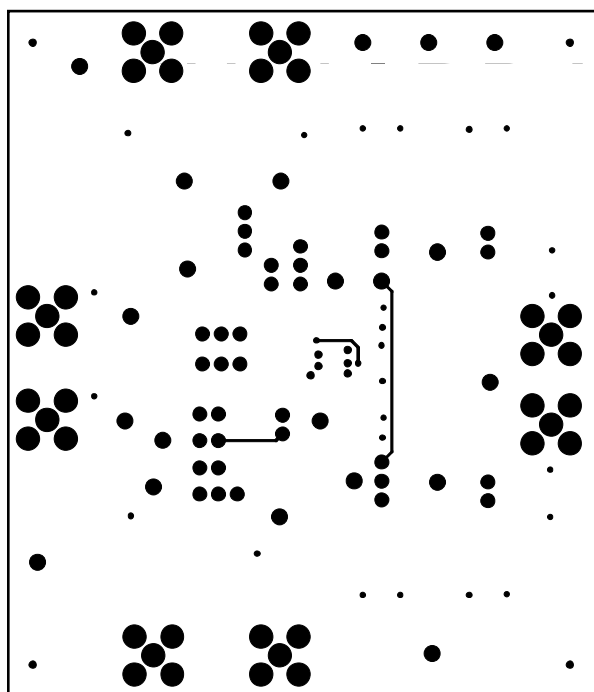


Figure 58. Secondary Side Copper

00540-058

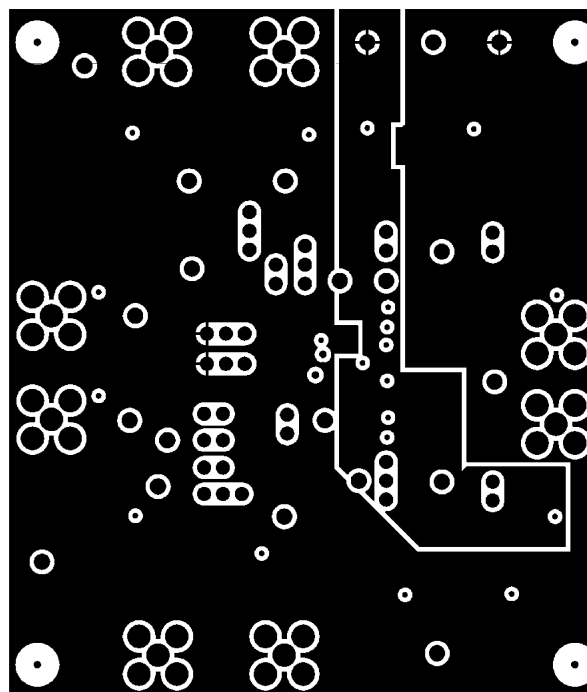
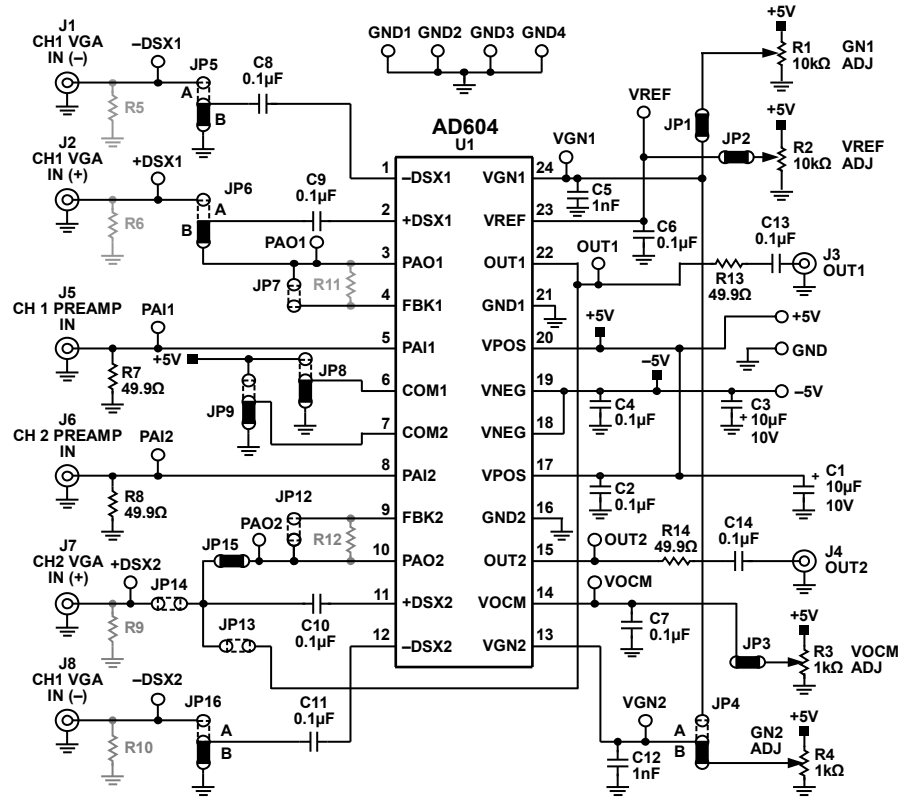


Figure 60. Internal Power Plane

00540-060



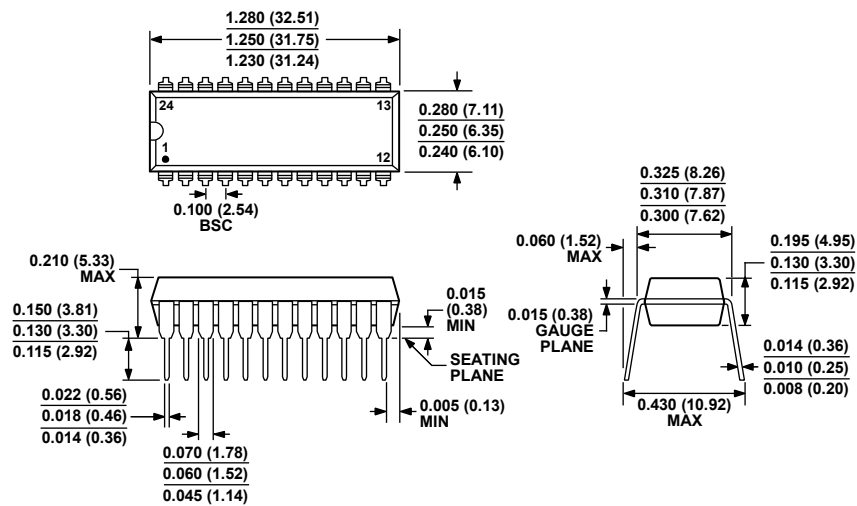
NOTES
1. PARTS IN GRAY ARE NOT INSTALLED.

Figure 61. Evaluation Board Schematic

Table 6. Bill of Materials

Qty.	Type	Description	Reference Designator	Manufacturer	Part Number
1	Test loop	Red	+5 V	Components Corp.	TP-104-01-02
1	Test loop	Blue	-5 V	Components Corp.	TP-104-01-06
5	Test loop	Black	GND, GND1, GND2, GND3, GND4	Components Corp.	TP-104-01-00
14	Test loop	Purple	+DSX1, +DSX2, -DSX1, -DSX2, OUT1, OUT2, PAI1, PAI2, PAO1, PAO2, VGN1, VGN2, VOCM, VREF	Components Corp.	TP-104-01-07
2	Capacitor	Tantalum 10 μ F, 10 V, A size	C1, C3	Nichicon	F931A106MAA
10	Capacitor	0.1 μ F, 50 V, 20%, 0805	C2, C4, C6, C7, C8, C9, C10, C11, C13, C14	Panasonic	PCC1840CT-ND
2	Capacitor	SM, 1000 pF, 50 V, 0805	C5, C12	Panasonic	ECU-V1H102KBN
8	Connector	SMA FEM PC Mount, RA	J1, J2, J3, J4, J5, J6, J7, J8	Amphenol	901-143-6RFX
8	Header	0.1" center 2-pin	JP1, JP2, JP3, JP7, JP12, JP13, JP14, JP15	Berg	69157-2
6	Header	0.1" center 3-pin	JP4, JP5, JP6, JP8, JP9, JP16	Molex	22-11-2032
4	Trimmer	10 k Ω , 1/4" SM	R1, R2, R3, R4	Bourns	3361P-1-103G
4	Resistor	49.9 Ω , 1%, 1/10 W, 0805	R7, R8, R13, R14	Panasonic	ERJ-6ENF49R9
1	Integrated circuit	40 MHz dual low noise VGA	U1	Analog Devices, Inc.	AD604AR
10	Jumper	Mini jumper; install in headers at JP1, JP2, JP3, JP4 lower, JP5 lower, JP6 lower, JP8 right, JP9 right, JP15, JP16 left			

OUTLINE DIMENSIONS

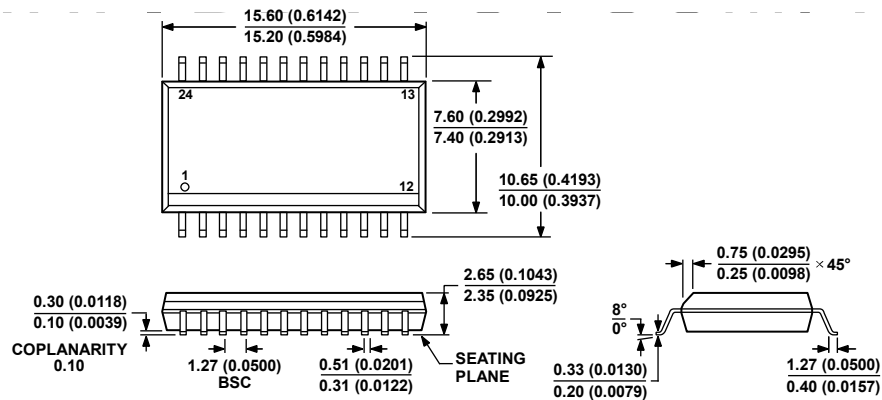


COMPLIANT TO JEDEC STANDARDS MS-001
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 62. 24-Lead Plastic Dual In-Line Package [PDIP]
Narrow Body
(N-24-1)

Dimensions shown in inches and (millimeters)

07106-A



COMPLIANT TO JEDEC STANDARDS MS-013-AD
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 63. 24-Lead Standard Small Outline Package [SOIC_W]
Wide Body
(RW-24)

Dimensions shown in millimeters and (inches)

080706-A

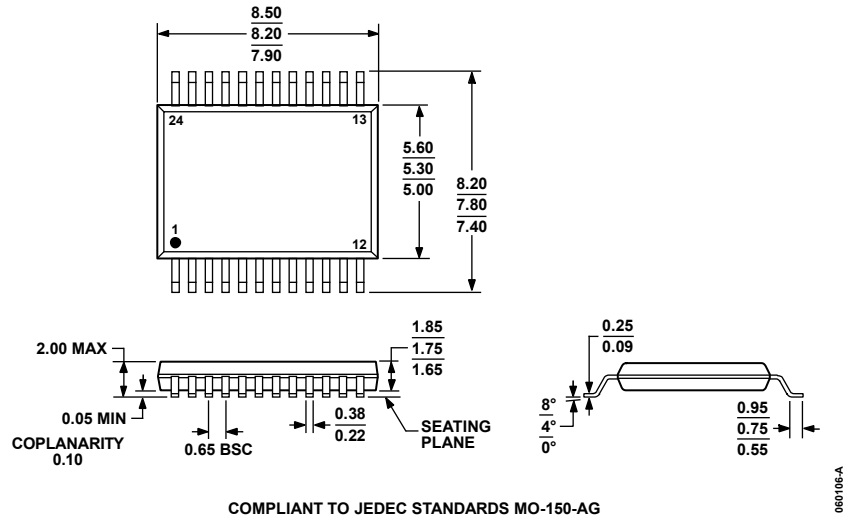


Figure 64. 24-Lead Shrink Small Outline Package [SSOP]
(RS-24)

Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
AD604AN	−40°C to +85°C	24-Lead Plastic Dual In-Line Package [PDIP]	N-24-1
AD604ANZ ¹	−40°C to +85°C	24-Lead Plastic Dual In-Line Package [PDIP]	N-24-1
AD604AR	−40°C to +85°C	24-Lead Standard Small Outline Package [SOIC_W]	RW-24
AD604AR-REEL	−40°C to +85°C	24-Lead Standard Small Outline Package [SOIC_W]	RW-24
AD604ARZ ¹	−40°C to +85°C	24-Lead Standard Small Outline Package [SOIC_W]	RW-24
AD604ARZ-RL ¹	−40°C to +85°C	24-Lead Standard Small Outline Package [SOIC_W]	RW-24
AD604ARS	−40°C to +85°C	24-Lead Shrink Small Outline Package [SSOP]	RS-24
AD604ARS-REEL	−40°C to +85°C	24-Lead Shrink Small Outline Package [SSOP]	RS-24
AD604ARS-REEL7	−40°C to +85°C	24-Lead Shrink Small Outline Package [SSOP]	RS-24
AD604ARSZ ¹	−40°C to +85°C	24-Lead Shrink Small Outline Package [SSOP]	RS-24
AD604ARSZ-RL ¹	−40°C to +85°C	24-Lead Shrink Small Outline Package [SSOP]	RS-24
AD604ARSZ-R7 ¹	−40°C to +85°C	24-Lead Shrink Small Outline Package [SSOP]	RS-24
AD604-EVALZ ¹		Evaluation Board	

¹ Z = RoHS Compliant Part.

AD604

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